



## TABLE OF CONTENTS

|                                                  |    |
|--------------------------------------------------|----|
| Features .....                                   | 1  |
| Applications .....                               | 1  |
| Companion Products .....                         | 1  |
| Functional Block Diagram .....                   | 1  |
| Revision History .....                           | 2  |
| General Description .....                        | 3  |
| Specifications.....                              | 4  |
| Timing Specifications .....                      | 6  |
| Absolute Maximum Ratings.....                    | 10 |
| Thermal Resistance .....                         | 10 |
| ESD Caution.....                                 | 10 |
| Pin Configuration and Function Descriptions..... | 11 |
| Typical Performance Characteristics .....        | 14 |
| Terminology .....                                | 18 |
| Theory of Operation .....                        | 19 |
| Converter Details.....                           | 19 |

|                                                                        |    |
|------------------------------------------------------------------------|----|
| Analog Input .....                                                     | 19 |
| ADC Transfer Function.....                                             | 20 |
| Internal/External Reference.....                                       | 21 |
| Typical Connection Diagram .....                                       | 22 |
| Power-Down Modes .....                                                 | 22 |
| Conversion Control .....                                               | 23 |
| Digital Interface .....                                                | 24 |
| Parallel Interface ( $\overline{\text{PAR}}/\text{SER SEL} = 0$ )..... | 24 |
| Serial Interface ( $\overline{\text{PAR}}/\text{SER SEL} = 1$ ).....   | 25 |
| Reading During Conversion .....                                        | 25 |
| Digital Filter .....                                                   | 26 |
| Layout Guidelines.....                                                 | 30 |
| Outline Dimensions .....                                               | 32 |
| Ordering Guide .....                                                   | 32 |

## REVISION HISTORY

### 8/2019—Rev. B to Rev. C

|                                                                                                   |    |
|---------------------------------------------------------------------------------------------------|----|
| Change to Table 1 .....                                                                           | 1  |
| Changes to Parallel/Serial Mode Parameter and Parallel/Read<br>Operation Parameter, Table 3 ..... | 6  |
| Changes to Track-and-Hold Amplifiers Section .....                                                | 20 |
| Changes to Ordering Guide .....                                                                   | 32 |

### 5/2018—Rev. A to Rev. B

|                                                     |    |
|-----------------------------------------------------|----|
| Changes to Patent Note, Note 1 .....                | 1  |
| Change to $t_{\text{CONV}}$ Parameter, Table 3..... | 6  |
| Changes to Ordering Guide .....                     | 32 |

### 1/2012—Rev. 0 to Rev. A

|                                              |    |
|----------------------------------------------|----|
| Changes to Analog Input Ranges Section ..... | 19 |
|----------------------------------------------|----|

### 4/2011—Revision 0: Initial Version

## GENERAL DESCRIPTION

The AD7608 is an 18-bit, 8-channel simultaneous sampling, analog-to-digital data acquisition system (DAS). The part contains analog input clamp protection, a second-order antialiasing filter, a track-and-hold amplifier, an 18-bit charge redistribution successive approximation analog-to-digital converter (ADC), a flexible digital filter, a 2.5 V reference and reference buffer, and high speed serial and parallel interfaces.

The AD7608 operates from a single 5 V supply and can accommodate  $\pm 10$  V and  $\pm 5$  V true bipolar input signals while sampling at throughput rates up to 200 kSPS for all channels.

The input clamp protection circuitry can tolerate voltages up to  $\pm 16.5$  V. The AD7608 has 1 M $\Omega$  analog input impedance regardless of sampling frequency. The single supply operation, on-chip filtering, and high input impedance eliminate the need for driver op amps and external bipolar supplies. The AD7608 antialiasing filter has a 3 dB cutoff frequency of 22 kHz and provides 40 dB antialias rejection when sampling at 200 kSPS. The flexible digital filter is pin driven, yields improvements in SNR, and reduces the 3 dB bandwidth.

## SPECIFICATIONS

$V_{REF} = 2.5\text{ V}$  external/internal,  $AV_{CC} = 4.75\text{ V}$  to  $5.25\text{ V}$ ,  $V_{DRIVE} = 2.3\text{ V}$  to  $5.25\text{ V}$ ;  $f_{SAMPLE} = 200\text{ kSPS}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.<sup>1</sup>

Table 2.

| Parameter                                           | Test Conditions/Comments                                              | Min  | Typ        | Max        | Unit                         |
|-----------------------------------------------------|-----------------------------------------------------------------------|------|------------|------------|------------------------------|
| <b>DYNAMIC PERFORMANCE</b>                          |                                                                       |      |            |            |                              |
| Signal-to-Noise Ratio (SNR) <sup>2, 3</sup>         | $f_{IN} = 1\text{ kHz}$ sine wave unless otherwise noted              |      |            |            |                              |
|                                                     | Oversampling by 16; $\pm 10\text{ V}$ range; $f_{IN} = 130\text{ Hz}$ | 98   | 99.5       |            | dB                           |
|                                                     | Oversampling by 16; $\pm 5\text{ V}$ range; $f_{IN} = 130\text{ Hz}$  | 95.5 | 97.5       |            | dB                           |
|                                                     | No oversampling; $\pm 10\text{ V}$ range                              | 89.5 | 90.9       |            | dB                           |
| Signal-to-(Noise + Distortion) (SINAD) <sup>2</sup> | No oversampling; $\pm 5\text{ V}$ range                               | 88.5 | 90         |            | dB                           |
|                                                     | No oversampling; $\pm 10\text{ V}$ range                              | 88.5 | 90.5       |            | dB                           |
|                                                     | No oversampling; $\pm 5\text{ V}$ range                               | 88   | 89.5       |            | dB                           |
|                                                     | No oversampling; $\pm 10\text{ V}$ range                              |      | 91.5       |            | dB                           |
| Dynamic Range                                       | No oversampling; $\pm 5\text{ V}$ range                               |      | 90.5       |            | dB                           |
|                                                     |                                                                       |      | –107       | –95        | dB                           |
| Total Harmonic Distortion (THD) <sup>2</sup>        |                                                                       |      |            |            | dB                           |
| Peak Harmonic or Spurious Noise (SFDR) <sup>2</sup> |                                                                       |      | –108       |            | dB                           |
| Intermodulation Distortion (IMD) <sup>2</sup>       | $f_a = 1\text{ kHz}$ , $f_b = 1.1\text{ kHz}$                         |      |            |            |                              |
|                                                     |                                                                       |      | –110       |            | dB                           |
|                                                     |                                                                       |      | –106       |            | dB                           |
| Channel-to-Channel Isolation <sup>2</sup>           | $f_{IN}$ on unselected channels up to $160\text{ kHz}$                |      | –95        |            | dB                           |
| <b>ANALOG INPUT FILTER</b>                          |                                                                       |      |            |            |                              |
| Full Power Bandwidth                                | –3 dB, $\pm 10\text{ V}$ range                                        |      | 23         |            | kHz                          |
|                                                     | –3 dB, $\pm 5\text{ V}$ range                                         |      | 15         |            | kHz                          |
|                                                     | –0.1 dB, $\pm 10\text{ V}$ range                                      |      | 10         |            | kHz                          |
|                                                     | –0.1 dB, $\pm 5\text{ V}$ range                                       |      | 5          |            | kHz                          |
| $t_{GROUP\ DELAY}$                                  | $\pm 10\text{ V}$ range                                               |      | 11         |            | $\mu\text{s}$                |
|                                                     | $\pm 5\text{ V}$ range                                                |      | 15         |            | $\mu\text{s}$                |
| <b>DC ACCURACY</b>                                  |                                                                       |      |            |            |                              |
| Resolution                                          | No missing codes                                                      | 18   |            |            | Bits                         |
| Differential Nonlinearity <sup>2</sup>              |                                                                       |      | $\pm 0.75$ | –0.99/+2.6 | LSB <sup>4</sup>             |
| Integral Nonlinearity <sup>2</sup>                  |                                                                       |      | $\pm 2.5$  | $\pm 7.5$  | LSB                          |
| Total Unadjusted Error (TUE)                        | $\pm 10\text{ V}$ range                                               |      | $\pm 15$   |            | LSB                          |
|                                                     | $\pm 5\text{ V}$ range                                                |      | $\pm 40$   |            | LSB                          |
| Positive Full-Scale Error <sup>2, 5</sup>           | External reference                                                    |      | $\pm 15$   | $\pm 128$  | LSB                          |
|                                                     | Internal reference                                                    |      | $\pm 40$   |            | LSB                          |
| Positive Full-Scale Error Drift                     | External reference                                                    |      | $\pm 2$    |            | ppm/°C                       |
|                                                     | Internal reference                                                    |      | $\pm 7$    |            | ppm/°C                       |
| Positive Full-Scale Error Matching <sup>2</sup>     | $\pm 10\text{ V}$ range                                               |      | 12         | 95         | LSB                          |
|                                                     | $\pm 5\text{ V}$ range                                                |      | 30         | 128        | LSB                          |
| Bipolar Zero Code Error <sup>2, 6</sup>             | $\pm 10\text{ V}$ range                                               |      | $\pm 3.5$  | $\pm 24$   | LSB                          |
|                                                     | $\pm 5\text{ V}$ range                                                |      | $\pm 3.5$  | $\pm 48$   | LSB                          |
| Bipolar Zero Code Error Drift                       | $\pm 10\text{ V}$ range                                               |      | 10         |            | $\mu\text{V}/^\circ\text{C}$ |
|                                                     | $\pm 5\text{ V}$ range                                                |      | 5          |            | $\mu\text{V}/^\circ\text{C}$ |
| Bipolar Zero Code Error Matching <sup>2</sup>       | $\pm 10\text{ V}$ range                                               |      | 3          | 30         | LSB                          |
|                                                     | $\pm 5\text{ V}$ range                                                |      | 21         | 65         | LSB                          |
| Negative Full-Scale Error <sup>2, 5</sup>           | External reference                                                    |      | $\pm 15$   | $\pm 128$  | LSB                          |
|                                                     | Internal reference                                                    |      | $\pm 40$   |            | LSB                          |
| Negative Full-Scale Error Drift                     | External reference                                                    |      | $\pm 4$    |            | ppm/°C                       |
|                                                     | Internal reference                                                    |      | $\pm 8$    |            | ppm/°C                       |
| Negative Full-Scale Error Matching <sup>2</sup>     | $\pm 10\text{ V}$ range                                               |      | 12         | 95         | LSB                          |
|                                                     | $\pm 5\text{ V}$ range                                                |      | 30         | 128        | LSB                          |

| Parameter                                      | Test Conditions/Comments                 | Min                    | Typ            | Max                    | Unit   |
|------------------------------------------------|------------------------------------------|------------------------|----------------|------------------------|--------|
| <b>ANALOG INPUT</b>                            |                                          |                        |                |                        |        |
| Input Voltage Ranges                           | RANGE = 1                                |                        |                | ±10                    | V      |
|                                                | RANGE = 0                                |                        |                | ±5                     | V      |
| Analog Input Current                           | 10 V; see Figure 28                      |                        | 5.4            |                        | μA     |
|                                                | 5 V; see Figure 28                       |                        | 2.5            |                        | μA     |
| Input Capacitance <sup>7</sup>                 |                                          |                        | 5              |                        | pF     |
| Input Impedance                                |                                          |                        | 1              |                        | MΩ     |
| <b>REFERENCE INPUT/OUTPUT</b>                  |                                          |                        |                |                        |        |
| Reference Input Voltage Range                  |                                          | 2.475                  | 2.5            | 2.525                  | V      |
| DC Leakage Current                             |                                          |                        |                | ±1                     | μA     |
| Input Capacitance <sup>7</sup>                 | REF SELECT = 1                           |                        | 7.5            |                        | pF     |
| Reference Output Voltage                       | REFIN/REFOUT                             |                        | 2.49/<br>2.505 |                        | V      |
| Reference Temperature Coefficient              |                                          |                        | ±10            |                        | ppm/°C |
| <b>LOGIC INPUTS</b>                            |                                          |                        |                |                        |        |
| Input High Voltage ( $V_{INH}$ )               |                                          | $0.9 \times V_{DRIVE}$ |                |                        | V      |
| Input Low Voltage ( $V_{INL}$ )                |                                          |                        |                | $0.1 \times V_{DRIVE}$ | V      |
| Input Current ( $I_{IN}$ )                     |                                          |                        |                | ±2                     | μA     |
| Input Capacitance ( $C_{IN}$ ) <sup>7</sup>    |                                          |                        | 5              |                        | pF     |
| <b>LOGIC OUTPUTS</b>                           |                                          |                        |                |                        |        |
| Output High Voltage ( $V_{OH}$ )               | $I_{SOURCE} = 100 \mu A$                 | $V_{DRIVE} - 0.2$      |                |                        | V      |
| Output Low Voltage ( $V_{OL}$ )                | $I_{SINK} = 100 \mu A$                   |                        |                | 0.2                    | V      |
| Floating-State Leakage Current                 |                                          |                        | ±1             | ±20                    | μA     |
| Floating-State Output Capacitance <sup>7</sup> |                                          |                        | 5              |                        | pF     |
| Output Coding                                  | Twos complement                          |                        |                |                        |        |
| <b>CONVERSION RATE</b>                         |                                          |                        |                |                        |        |
| Conversion Time                                | All eight channels included; see Table 3 |                        | 4              |                        | μs     |
| Track-and-Hold Acquisition Time                |                                          |                        | 1              |                        | μs     |
| Throughput Rate                                | Per channel, all eight channels included |                        |                | 200                    | kSPS   |
| <b>POWER REQUIREMENTS</b>                      |                                          |                        |                |                        |        |
| $AV_{CC}$                                      |                                          | 4.75                   |                | 5.25                   | V      |
| $V_{DRIVE}$                                    |                                          | 2.3                    |                | 5.25                   | V      |
| $I_{TOTAL}$                                    | Digital inputs = 0 V or $V_{DRIVE}$      |                        |                |                        |        |
| Normal Mode (Static)                           |                                          |                        | 16             | 22                     | mA     |
| Normal Mode (Operational) <sup>8</sup>         | $f_{SAMPLE} = 200 \text{ kSPS}$          |                        | 20             | 27                     | mA     |
| Standby Mode                                   |                                          |                        | 5              | 8                      | mA     |
| Shutdown Mode                                  |                                          |                        | 2              | 11                     | μA     |
| Power Dissipation                              |                                          |                        |                |                        |        |
| Normal Mode (Static)                           |                                          |                        | 80             | 115.5                  | mW     |
| Normal Mode (Operational) <sup>8</sup>         | $f_{SAMPLE} = 200 \text{ kSPS}$          |                        | 100            | 142                    | mW     |
| Standby Mode                                   |                                          |                        | 25             | 42                     | mW     |
| Shutdown Mode                                  |                                          |                        | 10             | 58                     | μW     |

<sup>1</sup> Temperature range for B version is -40°C to +85°C.

<sup>2</sup> See the Terminology section.

<sup>3</sup> This specification applies when reading during a conversion or after a conversion. If reading during a conversion in parallel mode with  $V_{DRIVE} = 5 \text{ V}$ , SNR typically reduces by 1.5 dB and THD by 3 dB.

<sup>4</sup> LSB means least significant bit. With  $\pm 5 \text{ V}$  input range, 1 LSB = 38.14 μV. With  $\pm 10 \text{ V}$  input range, 1 LSB = 76.29 μV.

<sup>5</sup> These specifications include the full temperature range variation and contribution from the internal reference buffer but do not include the error contribution from the external reference.

<sup>6</sup> Bipolar zero code error is calculated with respect to the analog input voltage.

<sup>7</sup> Sample tested during initial release to ensure compliance.

<sup>8</sup> Operational power/current figure includes contribution when running in oversampling mode.

## TIMING SPECIFICATIONS

$AV_{CC} = 4.75\text{ V to }5.25\text{ V}$ ,  $V_{DRIVE} = 2.3\text{ V to }5.25\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$  external reference/internal reference,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.<sup>1</sup>

Table 3.

| Parameter                     | Limit at T <sub>MIN</sub> , T <sub>MAX</sub> |     |      | Unit | Description                                                                                                                                                                              |
|-------------------------------|----------------------------------------------|-----|------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                               | Min                                          | Typ | Max  |      |                                                                                                                                                                                          |
| PARALLEL/SERIAL MODE          |                                              |     |      |      |                                                                                                                                                                                          |
| t <sub>CYCLE</sub>            |                                              |     | 5    | μs   | 1/throughput rate                                                                                                                                                                        |
|                               |                                              |     |      |      | Parallel mode, reading during or after conversion; or serial mode: V <sub>DRIVE</sub> = 3.3 V to 5.25 V, reading during a conversion using D <sub>OUTA</sub> and D <sub>OUTB</sub> lines |
|                               |                                              | 5   |      | μs   | Serial mode reading during conversion; V <sub>DRIVE</sub> = 2.7 V                                                                                                                        |
|                               |                                              |     | 10.5 | μs   | Serial mode reading after a conversion; V <sub>DRIVE</sub> = 2.3 V, D <sub>OUTA</sub> and D <sub>OUTB</sub> lines                                                                        |
| t <sub>CONV</sub>             |                                              |     |      |      | Conversion time                                                                                                                                                                          |
|                               | 3.45                                         | 4   | 4.2  | μs   | Oversampling off                                                                                                                                                                         |
|                               | 7.87                                         |     | 9.1  | μs   | Oversampling by 2                                                                                                                                                                        |
|                               | 16.05                                        |     | 18.8 | μs   | Oversampling by 4                                                                                                                                                                        |
|                               | 33                                           |     | 39   | μs   | Oversampling by 8                                                                                                                                                                        |
|                               | 66                                           |     | 78   | μs   | Oversampling by 16                                                                                                                                                                       |
|                               | 133                                          |     | 158  | μs   | Oversampling by 32                                                                                                                                                                       |
|                               | 257                                          |     | 315  | μs   | Oversampling by 64                                                                                                                                                                       |
| t <sub>WAKE-UP STANDBY</sub>  |                                              |     | 100  | μs   | STBY rising edge to CONVST x rising edge; power-up time from standby mode                                                                                                                |
| t <sub>WAKE-UP SHUTDOWN</sub> |                                              |     |      |      |                                                                                                                                                                                          |
| Internal Reference            |                                              |     | 30   | ms   | STBY rising edge to CONVST x rising edge; power-up time from shutdown mode                                                                                                               |
| External Reference            |                                              |     | 13   | ms   | STBY rising edge to CONVST x rising edge; power-up time from shutdown mode                                                                                                               |
| t <sub>RESET</sub>            | 50                                           |     |      | ns   | RESET high pulse width                                                                                                                                                                   |
| t <sub>OS_SETUP</sub>         | 20                                           |     |      | ns   | BUSY to OS x pin setup time                                                                                                                                                              |
| t <sub>OS_HOLD</sub>          | 20                                           |     |      | ns   | BUSY to OS x pin hold time                                                                                                                                                               |
| t <sub>1</sub>                |                                              |     | 40   | ns   | CONVST x high to BUSY high                                                                                                                                                               |
| t <sub>2</sub>                | 25                                           |     |      | ns   | Minimum CONVST x low pulse                                                                                                                                                               |
| t <sub>3</sub>                | 25                                           |     |      | ns   | Minimum CONVST x high pulse                                                                                                                                                              |
| t <sub>4</sub>                | 0                                            |     |      | ns   | BUSY falling edge to CS falling edge setup time                                                                                                                                          |
| t <sub>5</sub> <sup>2</sup>   |                                              |     | 0.5  | ms   | Maximum delay allowed between CONVST A, CONVST B rising edges                                                                                                                            |
| t <sub>6</sub>                |                                              |     | 25   | ns   | Maximum time between last CS rising edge and BUSY falling edge                                                                                                                           |
| t <sub>7</sub>                | 25                                           |     |      | ns   | Minimum delay between RESET low to CONVST x high                                                                                                                                         |
| PARALLEL/READ OPERATION       |                                              |     |      |      |                                                                                                                                                                                          |
| t <sub>8</sub>                | 0                                            |     |      | ns   | CS to RD setup time                                                                                                                                                                      |
| t <sub>9</sub>                | 0                                            |     |      | ns   | CS to RD hold time                                                                                                                                                                       |
| t <sub>10</sub>               |                                              |     |      |      | RD low pulse width                                                                                                                                                                       |
|                               | 16                                           |     |      | ns   | V <sub>DRIVE</sub> above 4.75 V                                                                                                                                                          |
|                               | 21                                           |     |      | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                                                                           |
|                               | 25                                           |     |      | ns   | V <sub>DRIVE</sub> above 2.7 V                                                                                                                                                           |
|                               | 32                                           |     |      | ns   | V <sub>DRIVE</sub> above 2.3 V                                                                                                                                                           |
| t <sub>11</sub>               | 15                                           |     |      | ns   | RD high pulse width                                                                                                                                                                      |
| t <sub>12</sub>               | 22                                           |     |      | ns   | CS high pulse width (see Figure 5); CS and RD linked                                                                                                                                     |

| Parameter                    | Limit at T <sub>MIN</sub> , T <sub>MAX</sub> |      |     | Unit | Description                                                                                                                            |
|------------------------------|----------------------------------------------|------|-----|------|----------------------------------------------------------------------------------------------------------------------------------------|
|                              | Min                                          | Typ  | Max |      |                                                                                                                                        |
| t <sub>13</sub>              |                                              | 16   |     | ns   | Delay from $\overline{CS}$ until DB[15:0] three-state disabled<br>V <sub>DRIVE</sub> above 4.75 V                                      |
|                              |                                              | 20   |     | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 25   |     | ns   | V <sub>DRIVE</sub> above 2.7 V                                                                                                         |
|                              |                                              | 30   |     | ns   | V <sub>DRIVE</sub> above 2.3 V                                                                                                         |
| t <sub>14</sub> <sup>3</sup> |                                              |      |     |      | Data access time after $\overline{RD}$ falling edge                                                                                    |
|                              |                                              | 16   |     | ns   | V <sub>DRIVE</sub> above 4.75 V                                                                                                        |
|                              |                                              | 21   |     | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 25   |     | ns   | V <sub>DRIVE</sub> above 2.7 V                                                                                                         |
|                              |                                              | 32   |     | ns   | V <sub>DRIVE</sub> above 2.3 V                                                                                                         |
| t <sub>15</sub>              | 6                                            |      |     | ns   | Data hold time after $\overline{RD}$ falling edge                                                                                      |
| t <sub>16</sub>              | 6                                            |      |     | ns   | $\overline{CS}$ to DB[15:0] hold time                                                                                                  |
| t <sub>17</sub>              |                                              | 22   |     | ns   | Delay from $\overline{CS}$ rising edge to DB[15:0] three-state enabled                                                                 |
| SERIAL READ OPERATION        |                                              |      |     |      |                                                                                                                                        |
| f <sub>SCLK</sub>            |                                              | 23.5 |     | MHz  | Frequency of serial read clock<br>V <sub>DRIVE</sub> above 4.75 V                                                                      |
|                              |                                              | 17   |     | MHz  | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 14.5 |     | MHz  | V <sub>DRIVE</sub> above 2.7 V                                                                                                         |
|                              |                                              | 11.5 |     | MHz  | V <sub>DRIVE</sub> above 2.3 V                                                                                                         |
| t <sub>18</sub>              |                                              |      |     |      | Delay from $\overline{CS}$ until D <sub>OUT</sub> A/D <sub>OUT</sub> B three-state disabled/delay from $\overline{CS}$ until MSB valid |
|                              |                                              | 15   |     | ns   | V <sub>DRIVE</sub> above 4.75 V                                                                                                        |
|                              |                                              | 20   |     | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 30   |     | ns   | V <sub>DRIVE</sub> = 2.3 V to 2.7 V                                                                                                    |
| t <sub>19</sub> <sup>3</sup> |                                              |      |     |      | Data access time after SCLK rising edge                                                                                                |
|                              |                                              | 17   |     | ns   | V <sub>DRIVE</sub> above 4.75 V                                                                                                        |
|                              |                                              | 23   |     | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 27   |     | ns   | V <sub>DRIVE</sub> above 2.7 V                                                                                                         |
|                              |                                              | 34   |     | ns   | V <sub>DRIVE</sub> above 2.3 V                                                                                                         |
| t <sub>20</sub>              | 0.4 t <sub>SCLK</sub>                        |      |     | ns   | SCLK low pulse width                                                                                                                   |
| t <sub>21</sub>              | 0.4 t <sub>SCLK</sub>                        |      |     | ns   | SCLK high pulse width                                                                                                                  |
| t <sub>22</sub>              | 7                                            |      |     | ns   | SCLK rising edge to D <sub>OUT</sub> A/D <sub>OUT</sub> B valid hold time                                                              |
| t <sub>23</sub>              |                                              | 22   |     | ns   | $\overline{CS}$ rising edge to D <sub>OUT</sub> A/D <sub>OUT</sub> B three-state enabled                                               |
| FRSTDATA OPERATION           |                                              |      |     |      |                                                                                                                                        |
| t <sub>24</sub>              |                                              | 15   |     | ns   | Delay from $\overline{CS}$ falling edge until FRSTDATA three-state disabled<br>V <sub>DRIVE</sub> above 4.75 V                         |
|                              |                                              | 20   |     | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 25   |     | ns   | V <sub>DRIVE</sub> above 2.7 V                                                                                                         |
|                              |                                              | 30   |     | ns   | V <sub>DRIVE</sub> above 2.3 V                                                                                                         |
| t <sub>25</sub>              |                                              |      |     | ns   | Delay from $\overline{CS}$ falling edge until FRSTDATA high, serial mode                                                               |
|                              |                                              | 15   |     | ns   | V <sub>DRIVE</sub> above 4.75 V                                                                                                        |
|                              |                                              | 20   |     | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 25   |     | ns   | V <sub>DRIVE</sub> above 2.7 V                                                                                                         |
|                              |                                              | 30   |     | ns   | V <sub>DRIVE</sub> above 2.3 V                                                                                                         |
| t <sub>26</sub>              |                                              |      |     |      | Delay from $\overline{RD}$ falling edge to FRSTDATA high                                                                               |
|                              |                                              | 16   |     | ns   | V <sub>DRIVE</sub> above 4.75 V                                                                                                        |
|                              |                                              | 20   |     | ns   | V <sub>DRIVE</sub> above 3.3 V                                                                                                         |
|                              |                                              | 25   |     | ns   | V <sub>DRIVE</sub> above 2.7 V                                                                                                         |
|                              |                                              | 30   |     | ns   | V <sub>DRIVE</sub> above 2.3 V                                                                                                         |

| Parameter       | Limit at T <sub>MIN</sub> , T <sub>MAX</sub> |     |     | Unit | Description                                                                                           |
|-----------------|----------------------------------------------|-----|-----|------|-------------------------------------------------------------------------------------------------------|
|                 | Min                                          | Typ | Max |      |                                                                                                       |
| t <sub>27</sub> |                                              |     | 19  | ns   | Delay from RD falling edge to FRSTDATA low<br>V <sub>DRIVE</sub> = 3.3 V to 5.25 V                    |
|                 |                                              |     | 24  | ns   | V <sub>DRIVE</sub> = 2.3 V to 2.7 V                                                                   |
| t <sub>28</sub> |                                              |     | 17  | ns   | Delay from 16 <sup>th</sup> SCLK falling edge to FRSTDATA low<br>V <sub>DRIVE</sub> = 3.3 V to 5.25 V |
|                 |                                              |     | 22  | ns   | V <sub>DRIVE</sub> = 2.3 V to 2.7 V                                                                   |
| t <sub>29</sub> |                                              |     | 24  | ns   | Delay from CS rising edge until FRSTDATA three-state enabled                                          |

<sup>1</sup> Sample tested during initial release to ensure compliance. All input signals are specified with t<sub>R</sub> = t<sub>F</sub> = 5 ns (10% to 90% of V<sub>DD</sub>) and timed from a voltage level of 1.6 V.

<sup>2</sup> The delay between the CONVST x signals was measured as the maximum time allowed while ensuring a <40 LSB performance matching between channel sets.

<sup>3</sup> A buffer is used on the data output pins for these measurements, which is equivalent to a load of 20 pF on the output pins.

### Timing Diagrams

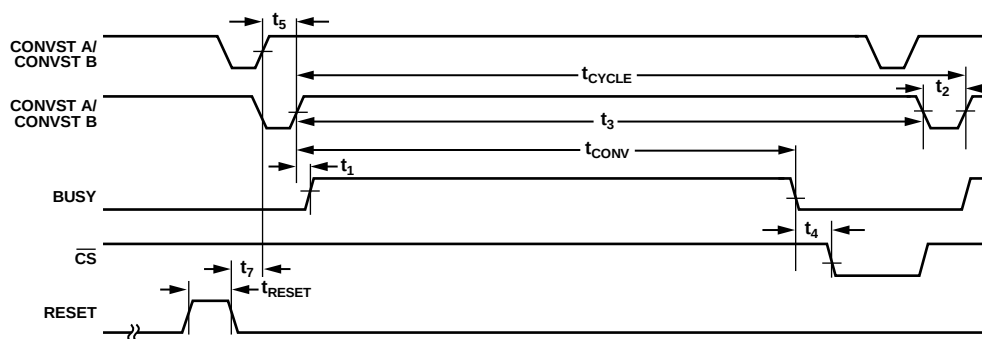


Figure 2. CONVST x Timing—Reading After a Conversion

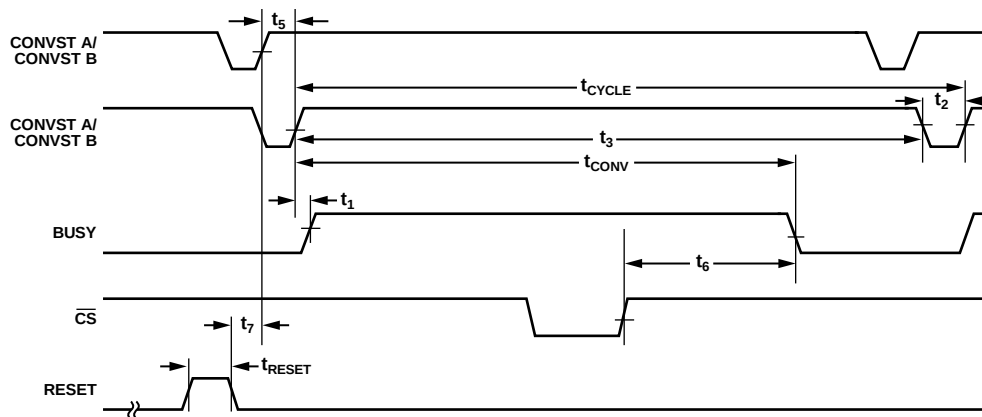


Figure 3. CONVST x Timing—Reading During a Conversion

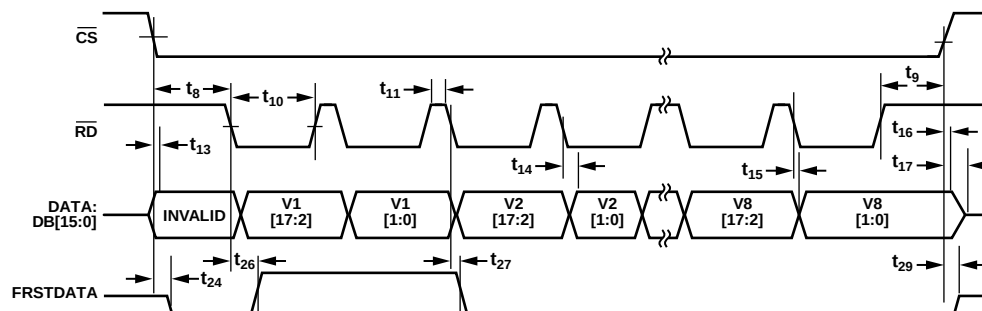


Figure 4. Parallel Mode Separate CS and RD Pulses

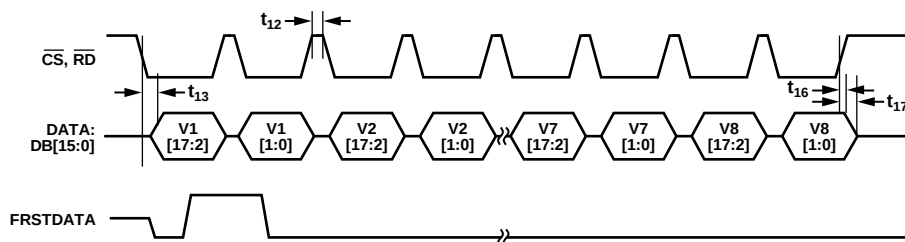
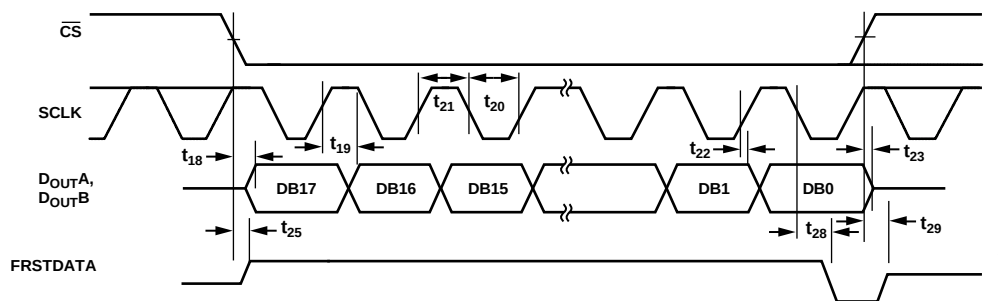
Figure 5.  $\overline{CS}$  and  $\overline{RD}$  Linked Parallel Mode

Figure 6. Serial Read Operation (Channel 1)

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 4.

| Parameter                                             | Rating                                      |
|-------------------------------------------------------|---------------------------------------------|
| $AV_{CC}$ to AGND                                     | $-0.3\text{ V to }+7\text{ V}$              |
| $V_{DRIVE}$ to AGND                                   | $-0.3\text{ V to }AV_{CC} + 0.3\text{ V}$   |
| Analog Input Voltage to AGND <sup>1</sup>             | $\pm 16.5\text{ V}$                         |
| Digital Input Voltage to AGND                         | $-0.3\text{ V to }V_{DRIVE} + 0.3\text{ V}$ |
| Digital Output Voltage to AGND                        | $-0.3\text{ V to }V_{DRIVE} + 0.3\text{ V}$ |
| REFIN to AGND                                         | $-0.3\text{ V to }AV_{CC} + 0.3\text{ V}$   |
| Input Current to Any Pin Except Supplies <sup>1</sup> | $\pm 10\text{ mA}$                          |
| Operating Temperature Range                           |                                             |
| B Version                                             | $-40^\circ\text{C to }+85^\circ\text{C}$    |
| Storage Temperature Range                             | $-65^\circ\text{C to }+150^\circ\text{C}$   |
| Junction Temperature                                  | $150^\circ\text{C}$                         |
| Pb/SN Temperature, Soldering                          |                                             |
| Reflow (10 sec to 30 sec)                             | $240 (+0)^\circ\text{C}$                    |
| Pb-Free Temperature, Soldering Reflow                 | $260 (+0)^\circ\text{C}$                    |
| ESD (All Pins Except Analog Inputs)                   | $2\text{ kV}$                               |
| ESD (Analog Input Pins Only)                          | $7\text{ kV}$                               |

<sup>1</sup> Transient currents of up to 100 mA do not cause SCR latch-up.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

$\theta_{JA}$  is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages. These specifications apply to a 4-layer board.

Table 5. Thermal Resistance

| Package Type | $\theta_{JA}$ | $\theta_{JC}$ | Unit               |
|--------------|---------------|---------------|--------------------|
| 64-Lead LQFP | 45            | 11            | $^\circ\text{C/W}$ |

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

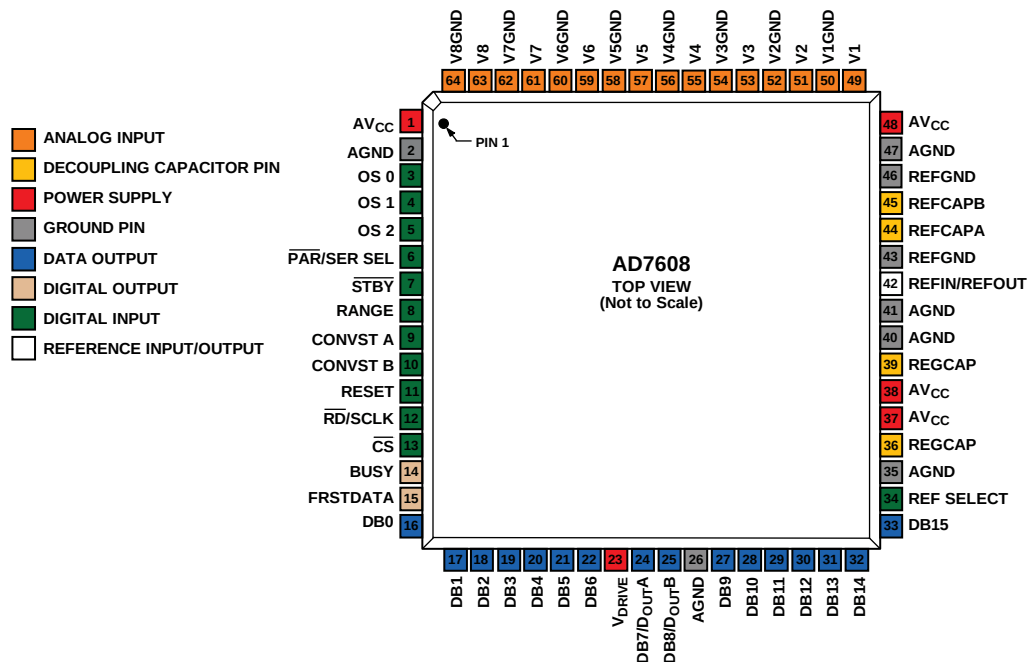


Figure 7. Pin Configuration

06938-007

Table 6. Pin Function Descriptions

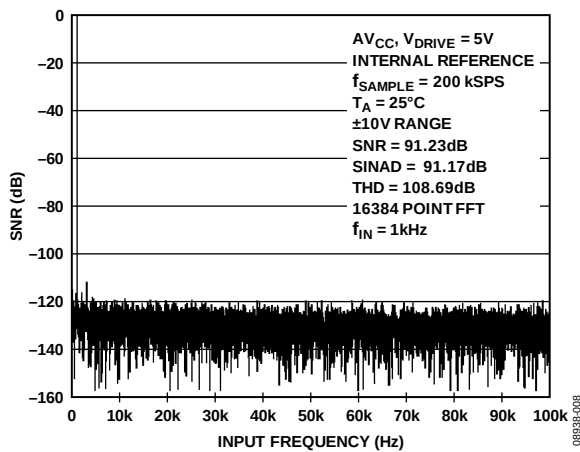
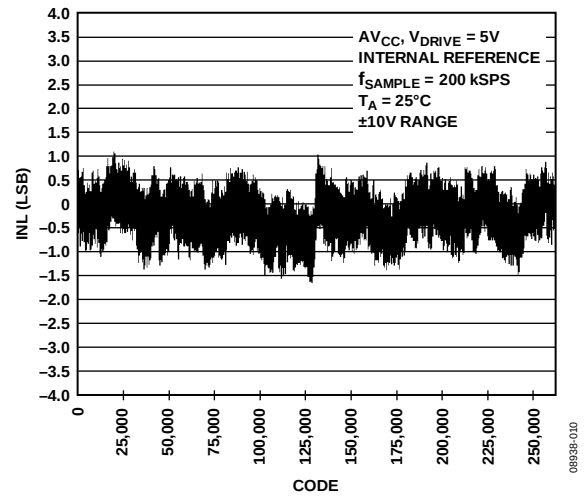
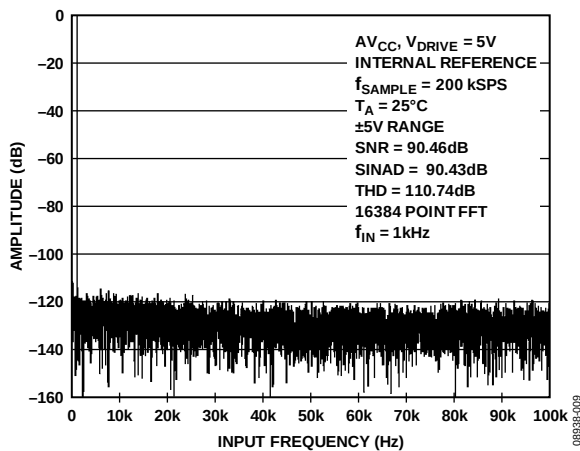
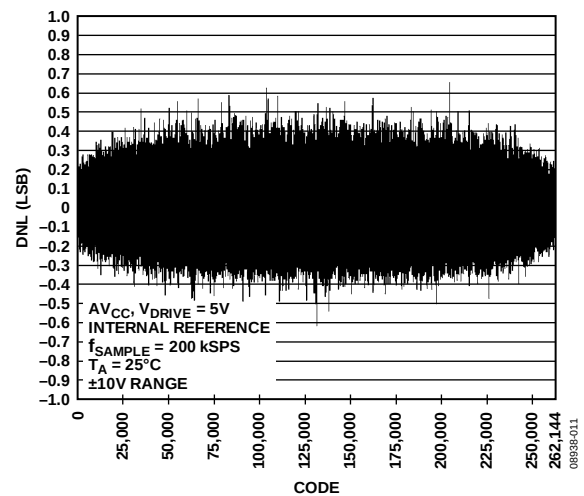
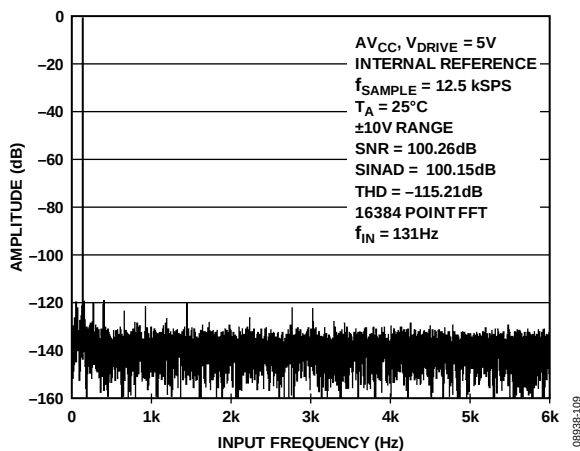
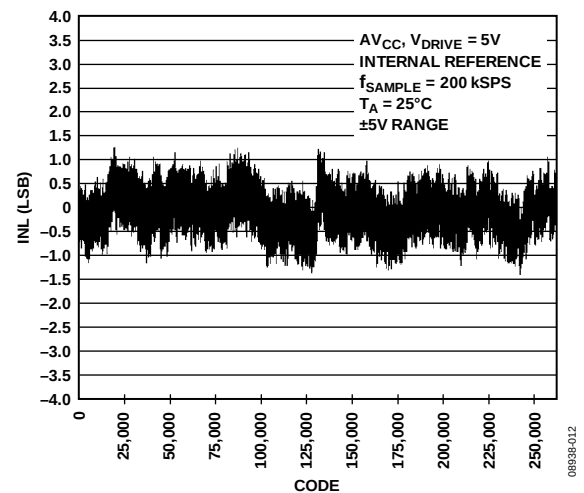
| Pin No.               | Type <sup>1</sup> | Mnemonic           | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-----------------------|-------------------|--------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1, 37, 38, 48         | P                 | AV <sub>CC</sub>   | Analog Supply Voltage 4.75 V to 5.25 V. This supply voltage is applied to the internal front-end amplifiers and to the ADC core. These supply pins should be decoupled to AGND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 2, 26, 35, 40, 41, 47 | P                 | AGND               | Analog Ground. This pin is the ground reference point for all analog circuitry on the AD7608. All analog input signals and external reference signals should be referred to these pins. All six of these AGND pins should connect to the AGND plane of a system.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 5, 4, 3               | DI                | OS [2:0]           | Oversampling Mode Pins. Logic inputs. These inputs are used to select the oversampling ratio. OS 2 is the MSB control bit, while OS 0 is the LSB control bit. See the Digital Filter section for further details on the oversampling mode of operation and Table 8 for oversampling bit decoding.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 6                     | DI                | PAR/SER SEL        | Parallel/Serial Interface Selection Input. Logic input. If this pin is tied to a logic low, the parallel interface is selected. If this pin is tied to a logic high, the serial interface is selected. In serial mode, the RD/SCLK pin functions as the serial clock input. The DB7/D <sub>OUT</sub> A and DB8/D <sub>OUT</sub> B pins function as serial data outputs. When the serial interface is selected, DB[15:9] and DB[6:0] pins should be tied to GND.                                                                                                                                                                                                                                                                                                                                                              |
| 7                     | DI                | STBY               | Standby Mode Input. This pin is used to place the AD7608 into one of two power-down modes: standby mode or shutdown mode. The power-down mode entered depends on the state of the RANGE pin as shown in Table 7. When in standby mode, all circuitry, except the on-chip reference regulators, and regulator buffers, is powered down. When in shutdown mode, all circuitry is powered down.                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 8                     | DI                | RANGE              | Analog Input Range Selection. Logic input. The polarity on this pin determines the input range of the analog input channels. If this pin is tied to a logic high, the analog input range is $\pm 10$ V for all channels. If this pin is tied to a logic low, the analog input range is $\pm 5$ V for all channels. A logic change on this pin has an immediate effect on the analog input range. Changing this pin during a conversion is not recommended. See the Analog Input section for more details.                                                                                                                                                                                                                                                                                                                    |
| 9, 10                 | DI                | CONVST A, CONVST B | Conversion Start Input A, Conversion Start Input B. Logic inputs. These logic inputs are used to initiate conversions on the analog input channels. For simultaneous sampling of all input channels, CONVST A and CONVST B can be shorted together and a single convert start signal applied. Alternatively, CONVST A can be used to initiate simultaneous sampling for V1, V2, V3, and V4, and CONVST B can be used to initiate simultaneous sampling on the other analog inputs (V5, V6, V7, and V8). This is only possible when oversampling is not switched on. When the CONVST A or CONVST B pin transitions from low to high, the front-end track-and-hold circuitry for their respective analog inputs is set to hold. This function allows a phase delay to be created inherently between the sets of analog inputs. |

| Pin No.  | Type <sup>1</sup> | Mnemonic             | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|----------|-------------------|----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11       | DI                | RESET                | Reset Input. When set to logic high, the rising edge of RESET resets the AD7608. Once $t_{WAKE-UP}$ has elapsed, the part should receive a RESET pulse after power up. The RESET high pulse should be typically 100 ns wide. If a RESET pulse is applied during a conversion, the conversion is aborted. If a RESET pulse is applied during a read, the contents of the output registers resets to all zeros.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 12       | DI                | $\overline{RD}/SCLK$ | Parallel Data Read Control Input when Parallel Interface is Selected ( $\overline{RD}$ )/Serial Clock Input when the Serial Interface is Selected (SCLK). When both $\overline{CS}$ and $\overline{RD}$ are logic low in parallel mode, the output bus is enabled.<br>In parallel mode, two $\overline{RD}$ pulses are required to read the full 18 bits of conversion results from each channel. The first $\overline{RD}$ pulse outputs DB[17:2], the second $\overline{RD}$ pulse outputs DB[1:0].<br>In serial mode, this pin acts as the serial clock input for data transfers. The $\overline{CS}$ falling edge takes the data output lines, $D_{OUTA}$ and $D_{OUTB}$ , out of three-state and clocks out the MSB of the conversion result. The rising edge of SCLK clocks all subsequent data bits onto the $D_{OUTA}$ and $D_{OUTB}$ serial data outputs. For further information, see the Conversion Control section. |
| 13       | DI                | $\overline{CS}$      | Chip Select. This active low logic input frames the data transfer. When both $\overline{CS}$ and $\overline{RD}$ are logic low in parallel mode, the output bus, DB[15:0], is enabled and the conversion result is output on the parallel data bus lines. In serial mode, the $\overline{CS}$ is used to frame the serial read transfer and clock out the MSB of the serial output data.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 14       | DO                | BUSY                 | Busy Output. This pin transitions to a logic high after both CONVST A and CONVST B rising edges and indicates that the conversion process has started. The BUSY output remains high until the conversion process for all channels is complete. The falling edge of BUSY signals that the conversion data is being latched into the output data registers and is available to be read after a Time $t_d$ . Any data read while BUSY is high must be complete before the falling edge of BUSY occurs. Rising edges on CONVST A or CONVST B have no effect while the BUSY signal is high.                                                                                                                                                                                                                                                                                                                                          |
| 15       | DO                | FRSTDATA             | Digital Output. The FRSTDATA output signal indicates when the first channel, V1, is being read back on either the parallel or serial interface. When the $\overline{CS}$ input is high, the FRSTDATA output pin is in three-state. The falling edge of $\overline{CS}$ takes FRSTDATA out of three-state. In parallel mode, the falling edge of $\overline{RD}$ corresponding to the result of V1 then sets the FRSTDATA pin high indicating that the result from V1 is available on the output data bus. The FRSTDATA output returns to a logic low following the third falling edge of $\overline{RD}$ . In serial mode, FRSTDATA goes high on the falling edge of $\overline{CS}$ as this clocks out the MSB of V1 on $D_{OUTA}$ . It returns low on the 18 <sup>th</sup> SCLK falling edge after the $\overline{CS}$ falling edge. See the Conversion Control section for more details.                                     |
| 22 to 16 | DO                | DB[6:0]              | Parallel Output Data Bits, DB6 to DB0. When $\overline{PAR}/SER SEL = 0$ , these pins act as three-state parallel digital output pins. When $\overline{CS}$ and $\overline{RD}$ are low, these pins are used to output DB8 to DB2 of the conversion result during the first $\overline{RD}$ pulse and output 0 during the second $\overline{RD}$ pulse. When $\overline{PAR}/SER SEL = 1$ , these pins should be tied to GND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 23       | P                 | $V_{DRIVE}$          | Logic Power Supply Input. The voltage (2.3 V to 5.25 V) supplied at this pin determines the operating voltage of the interface. This pin is nominally at the same supply as the supply of the host interface (that is, DSP and FPGA).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 24       | DO                | DB7/ $D_{OUTA}$      | Parallel Output Data Bit 7 (DB7)/Serial Interface Data Output Pin ( $D_{OUTA}$ ). When $\overline{PAR}/SER SEL = 0$ , this pin acts as a three-state parallel digital output pin. When $\overline{CS}$ and $\overline{RD}$ are low, this pin is used to output DB9 of the conversion result. When $\overline{PAR}/SER SEL = 1$ , this pin functions as $D_{OUTA}$ and outputs serial conversion data. See the Conversion Control section for further details.                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 25       | DO                | DB8/ $D_{OUTB}$      | Parallel Output Data Bit 8 (DB8)/Serial Interface Data Output Pin ( $D_{OUTB}$ ). When $\overline{PAR}/SER SEL = 0$ , this pin acts as a three-state parallel digital output pin. When $\overline{CS}$ and $\overline{RD}$ are low, this pin is used to output DB10 of the conversion result. When $\overline{PAR}/SER SEL = 1$ , this pin functions as $D_{OUTB}$ and outputs serial conversion data. See the Conversion Control section for further details.                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 31 to 27 | DO                | DB[13:9]             | Parallel Output Data Bits, DB13 to DB9. When $\overline{PAR}/SER SEL = 0$ , these pins act as three-state parallel digital output pins. When $\overline{CS}$ and $\overline{RD}$ are low, these pins are used to output DB15 to DB11 of the conversion result during the first $\overline{RD}$ pulse and output zero during the second $\overline{RD}$ pulse. When $\overline{PAR}/SER SEL = 1$ , these pins should be tied to GND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 32       | DO/DI             | DB14                 | Parallel Output Data Bit 14 (DB14). When $\overline{PAR}/SER SEL = 0$ , this pin act as three-state parallel digital output pin. When $\overline{CS}$ and $\overline{RD}$ are low, this pin is used to output DB16 of the conversion result during the first $\overline{RD}$ pulse and DB0 of the same conversion result during the second $\overline{RD}$ pulse. When $\overline{PAR}/SER SEL = 1$ , this pins should be tied to GND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 33       | DO/DI             | DB15                 | Parallel Output Data Bit 15 (DB15). When $\overline{PAR}/SER SEL = 0$ , this pin acts as three-state parallel digital output pin. This pin is used to output DB17 of the conversion result during the first $\overline{RD}$ pulse and DB1 of the same conversion result during the second $\overline{RD}$ pulse. When $\overline{PAR}/SER SEL = 1$ , this pins should be tied to GND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |

| Pin No.                              | Type <sup>1</sup> | Mnemonic            | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|--------------------------------------|-------------------|---------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 34                                   | DI                | REF SELECT          | Internal/External Reference Selection Input. Logic input. If this pin is set to logic high then the internal reference is selected and is enabled, if this pin is set to logic low then the internal reference is disabled and an external reference voltage must be applied to the REFIN/REFOUT pin.                                                                                                                                                                                                                                                        |
| 36, 39                               | P                 | REGCAP              | Decoupling Capacitor Pins for Voltage Output from Internal Regulator. These output pins should be decoupled separately to AGND using a 1 $\mu$ F capacitor. The voltage on these output pins is in the range of 2.5 V to 2.7 V.                                                                                                                                                                                                                                                                                                                              |
| 42                                   | REF               | REFIN/<br>REFOUT    | Reference Input/Reference Output. The on-chip reference of 2.5 V is available on this pin for external use if the REF SELECT pin is set to a logic high. Alternatively, the internal reference can be disabled by setting the REF SELECT pin to a logic low and an external reference of 2.5 V can be applied to this input. See the Internal/External Reference section. Decoupling is required on this pin for both the internal or external reference options. A 10 $\mu$ F capacitor should be applied from this pin to ground close to the REFGND pins. |
| 43, 46                               | REF               | REFGND              | Reference Ground Pins. These pins should be connected to AGND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 44, 45                               | REF               | REFCAPA,<br>REFCAPB | Reference Buffer Output Force/Sense Pins. These pins must be connected together and decoupled to AGND using a low ESR 10 $\mu$ F ceramic capacitor.                                                                                                                                                                                                                                                                                                                                                                                                          |
| 49, 51, 53,<br>55, 57, 59,<br>61, 63 | AI                | V1 to V8            | Analog Inputs. These pins are single-ended analog inputs. The analog input range of these channels is determined by the RANGE pin.                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 50, 52, 54,<br>56, 58, 60,<br>62, 64 | AI/<br>GND        | V1GND to<br>V8GND   | Analog Input Ground Pins. These pins correspond to the V1 to V8 analog input pins. Connect all analog input AGND pins to the AGND plane of a system.                                                                                                                                                                                                                                                                                                                                                                                                         |

<sup>1</sup> Refers to classification of pin type; P denotes power, AI denotes analog input, REF denotes reference, DI denotes digital input, DO denotes digital output.

## TYPICAL PERFORMANCE CHARACTERISTICS

Figure 8. FFT Plot,  $\pm 10$  V RangeFigure 11. Typical INL,  $\pm 10$  V RangeFigure 9. FFT Plot,  $\pm 5$  V RangeFigure 12. Typical DNL,  $\pm 10$  V RangeFigure 10. FFT Over Sampling by 16,  $\pm 10$  V RangeFigure 13. Typical INL,  $\pm 5$  V Range

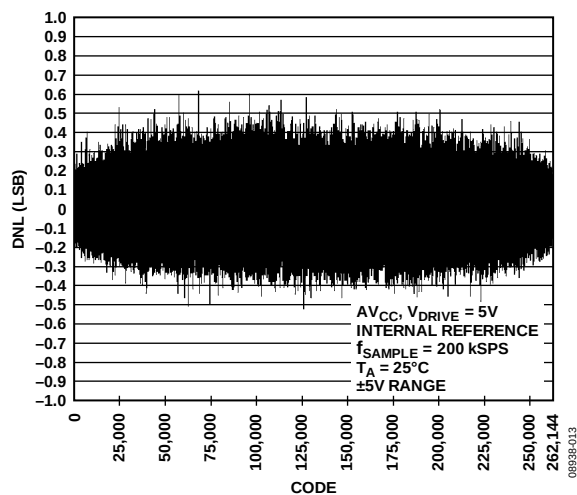
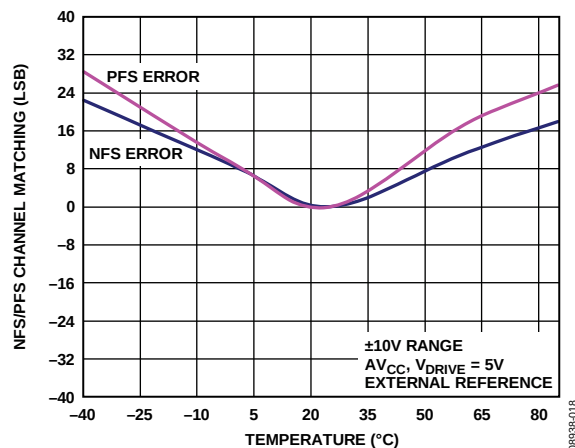
Figure 14. Typical DNL,  $\pm 5$  V Range

Figure 17. NFS/PFS Error Matching

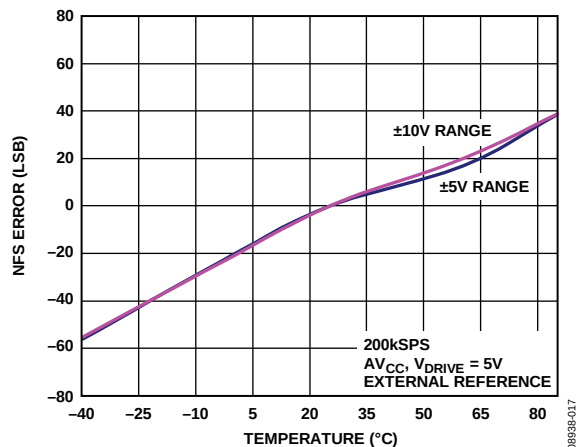


Figure 15. NFS Error vs. Temperature

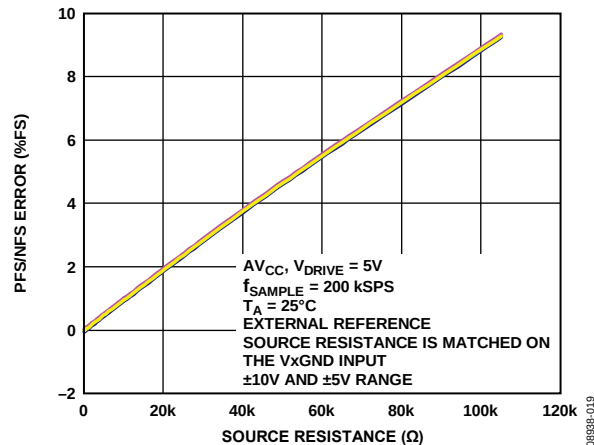


Figure 18. PFS/NFS Error vs. Source Resistance

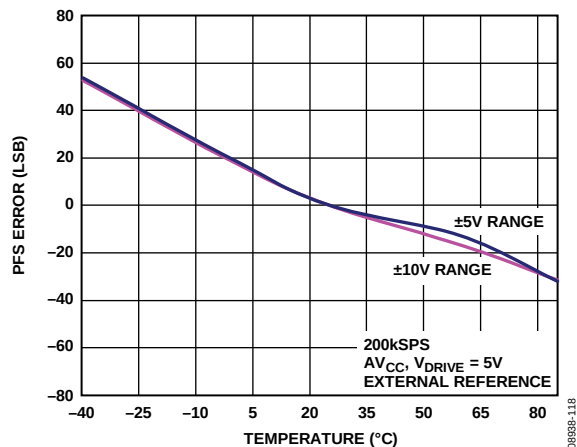
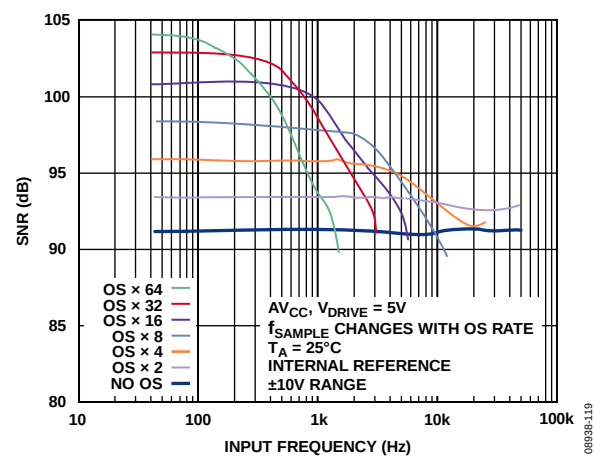


Figure 16. PFS Error vs. Temperature

Figure 19. SNR vs. Input Frequency for Different Oversampling Rates,  $\pm 10$  V Range

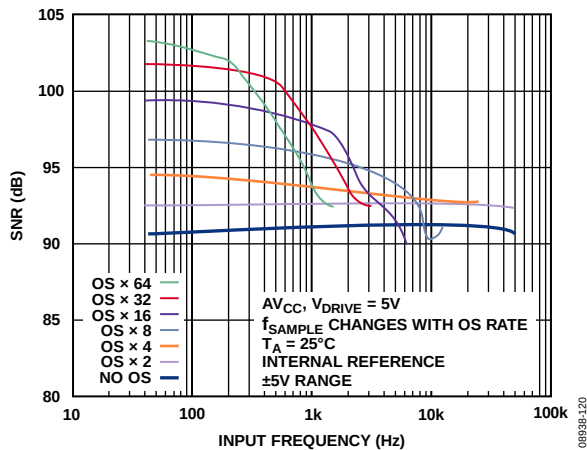


Figure 20. SNR vs. Input Frequency for Different Oversampling Rates,  $\pm 5$  V Range

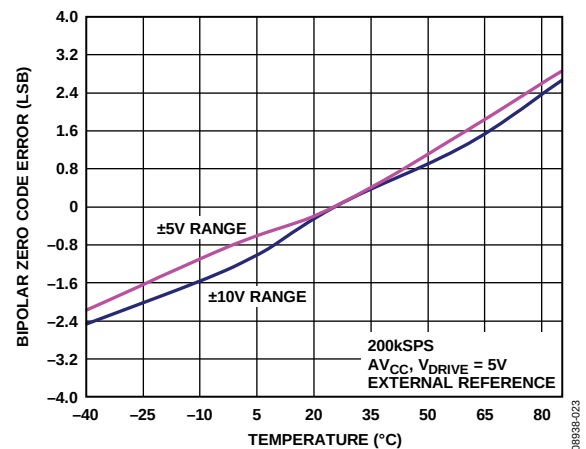


Figure 23. Bipolar Zero Code Error vs. Temperature

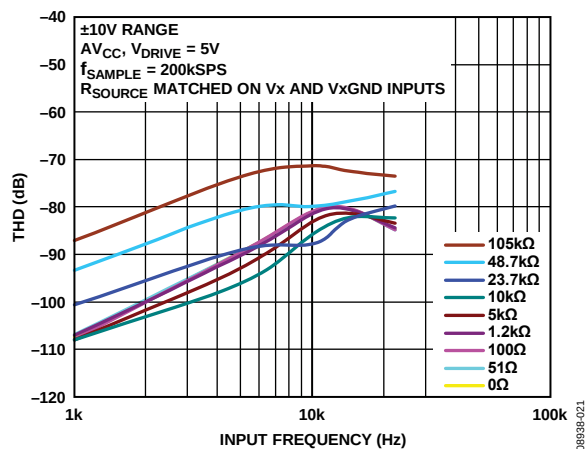


Figure 21. THD vs. Input Frequency for Various Source Impedances,  $\pm 10$  V Range

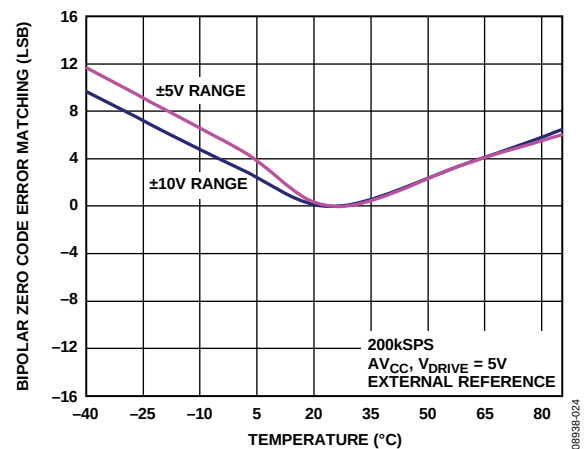


Figure 24. Bipolar Zero Code Error Matching Between Channels

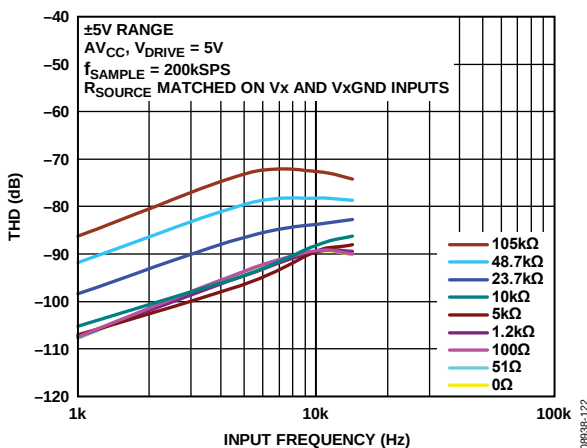


Figure 22. THD vs. Input Frequency for Various Source Impedances,  $\pm 5$  V Range

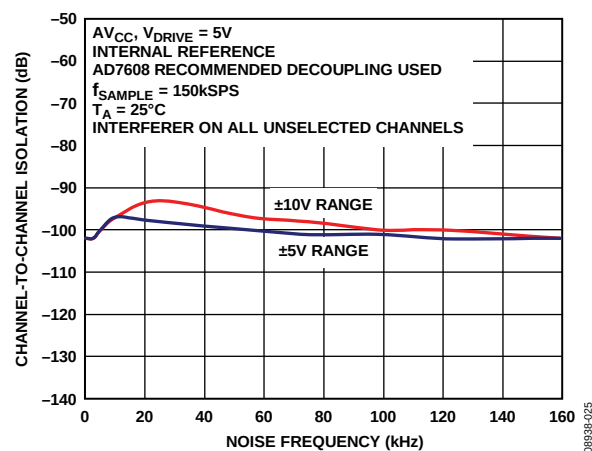


Figure 25. Channel-to-Channel Isolation

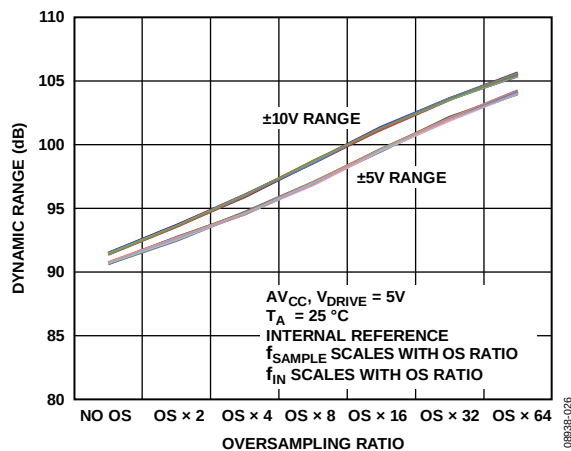


Figure 26. Dynamic Range vs. Oversampling Ratio

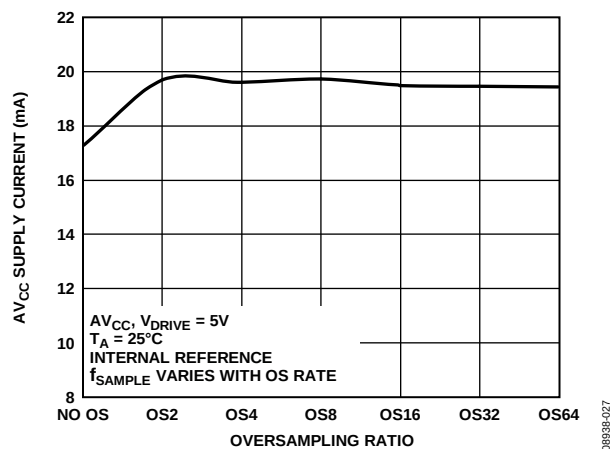


Figure 29. Supply Current vs. Oversampling Rate

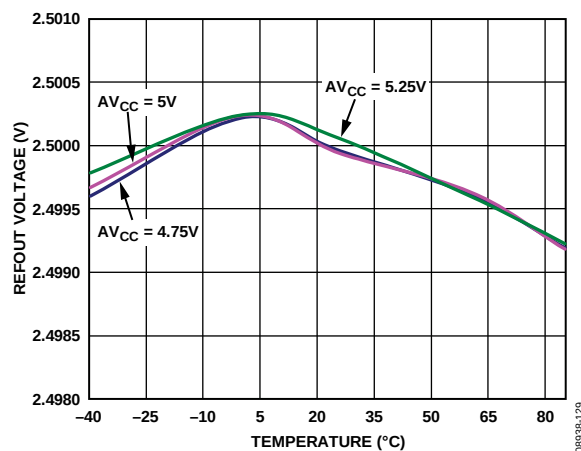


Figure 27. Reference Output Voltage vs. Temperature for Different Supply Voltages

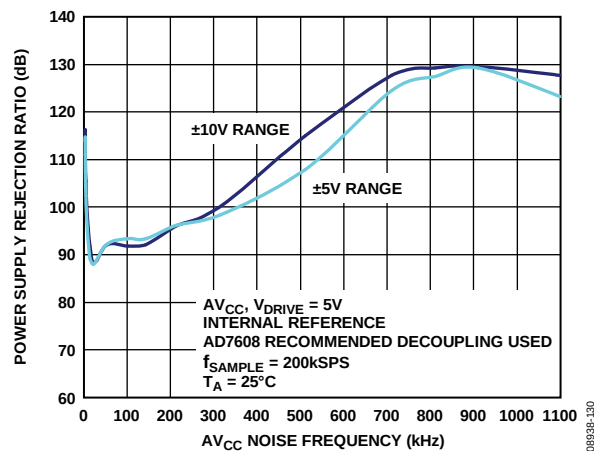


Figure 30. PSRR

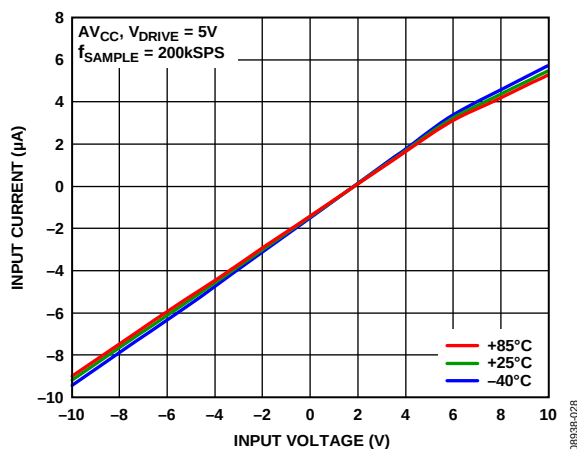


Figure 28. Analog Input Current vs. Input Voltage Across Temperature

## TERMINOLOGY

### Integral Nonlinearity

The maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale, at ½ LSB below the first code transition; and full scale, at ½ LSB above the last code transition.

### Differential Nonlinearity

The difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

### Bipolar Zero Code Error

The deviation of the midscale transition (all 1s to all 0s) from the ideal, which is 0 V – ½ LSB.

### Bipolar Zero Code Error Match

The absolute difference in bipolar zero code error between any two input channels.

### Positive Full-Scale Error

The deviation of the actual last code transition from the ideal last code transition (10 V – 1½ LSB (9.99988) and 5 V – 1½ LSB (4.99994)) after bipolar zero code error is adjusted out. The positive full-scale error includes the contribution from the internal reference buffer.

### Positive Full-Scale Error Match

The absolute difference in positive full-scale error between any two input channels.

### Negative Full-Scale Error

The deviation of the first code transition from the ideal first code transition (–10 V + ½ LSB (–9.99996) and –5 V + ½ LSB (–4.99998)) after the bipolar zero code error is adjusted out. The negative full-scale error includes the contribution from the internal reference buffer.

### Negative Full-Scale Error Match

The absolute difference in negative full-scale error between any two input channels.

### Signal-to-(Noise + Distortion) Ratio

The measured ratio of signal-to-(noise + distortion) at the output of the ADC. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( $f_s/2$ , excluding dc).

The ratio depends on the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise.

The theoretical signal-to-(noise + distortion) ratio for an ideal N-bit converter with a sine wave input is given by

$$\text{Signal-to-(Noise + Distortion)} = (6.02 N + 1.76) \text{ dB}$$

Thus, for an 18-bit converter, the signal-to-(noise + distortion) is 110.12 dB.

### Total Harmonic Distortion (THD)

The ratio of the rms sum of the harmonics to the fundamental. For the AD7608, it is defined as

$$\text{THD (dB)} = 20 \log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2 + V_7^2 + V_8^2 + V_9^2}}{V_1}$$

where:

$V_1$  is the rms amplitude of the fundamental.

$V_2$  to  $V_9$  are the rms amplitudes of the second through ninth harmonics.

### Peak Harmonic or Spurious Noise

The ratio of the rms value of the next largest component in the ADC output spectrum (up to  $f_s/2$ , excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for ADCs where the harmonics are buried in the noise floor, it is determined by a noise peak.

### Intermodulation Distortion (IMD)

With inputs consisting of sine waves at two frequencies,  $f_a$  and  $f_b$ , any active device with nonlinearities creates distortion products at sum and difference frequencies of  $m f_a \pm n f_b$ , where  $m, n = 0, 1, 2, 3$ . Intermodulation distortion terms are those for which neither  $m$  nor  $n$  is equal to 0. For example, the second-order terms include  $(f_a + f_b)$  and  $(f_a - f_b)$ , and the third-order terms include  $(2f_a + f_b)$ ,  $(2f_a - f_b)$ ,  $(f_a + 2f_b)$ , and  $(f_a - 2f_b)$ .

The calculation of the intermodulation distortion is per the THD specification, where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the sum of the fundamentals expressed in decibels (dB).

### Power Supply Rejection Ratio (PSRR)

Variations in power supply affect the full-scale transition but not the converter's linearity. PSR is the maximum change in full-scale transition point due to a change in power supply voltage from the nominal value. The PSR ratio (PSRR) is defined as the ratio of the power in the ADC output at full-scale frequency,  $f$ , to the power of a 100 mV p-p sine wave applied to the ADC's  $V_{DD}$  and  $V_{SS}$  supplies of Frequency  $f_s$ .

$$\text{PSRR (dB)} = 10 \log (P_f/P_{f_s})$$

where:

$P_f$  is equal to the power at Frequency  $f$  in the ADC output.

$P_{f_s}$  is equal to the power at Frequency  $f_s$  coupled onto the  $AV_{CC}$  supply.

### Channel-to-Channel Isolation

Channel-to-channel isolation is a measure of the level of crosstalk between all input channels. It is measured by applying a full-scale sine wave signal, up to 160 kHz, to all unselected input channels and then determining the degree to which the signal attenuates in the selected channel with a 1 kHz sine wave signal applied (see Figure 25).

## THEORY OF OPERATION

### CONVERTER DETAILS

The AD7608 is a data acquisition system that employs a high speed, low power, charge redistribution, successive approximation analog-to-digital converter (ADC) and allows the simultaneous sampling of eight analog input channels. The analog inputs on the AD7608 can accept true bipolar input signals. The RANGE pin is used to select either  $\pm 10$  V or  $\pm 5$  V as the input range. The AD7608 operates from a single 5 V supply.

The AD7608 contains input clamp protection, input signal scaling amplifiers, a second-order antialiasing filter, track-and-hold amplifiers, an on-chip reference, reference buffers, a high speed ADC, a digital filter, and high speed parallel and serial interfaces. Sampling on the AD7608 is controlled using the CONVST $x$  signals.

### ANALOG INPUT

#### Analog Input Ranges

The AD7608 can handle true bipolar, single-ended input voltages. The logic level on the RANGE pin determines the analog input range of all analog input channels. If this pin is tied to a logic high, the analog input range is  $\pm 10$  V for all channels. If this pin is tied to a logic low, the analog input range is  $\pm 5$  V for all channels. A logic change on the RANGE pin has an immediate effect on the analog input range; however, there is typically a settling time of approximately 80  $\mu$ s, in addition to the normal acquisition time requirement. The recommended practice is to hardwire the RANGE pin according to the desired input range for the system signals.

During normal operation, the applied analog input voltage should remain within the analog input range selected via the range pin. A RESET pulse must be applied after power-up to ensure the analog input channels are configured for the range selected.

When in a power-down mode, it is recommended to tie the analog inputs to GND. As per the Analog Input Clamp Protection section, the overvoltage clamp protection is recommended for use in transient overvoltage conditions and should not remain active for extended periods. Stressing the analog inputs outside of the conditions mentioned here may degrade the Bipolar Zero Code error and THD performance of the AD7608.

#### Analog Input Impedance

The analog input impedance of the AD7608 is 1 M $\Omega$ . This is a fixed input impedance that does not vary with the AD7608 sampling frequency. This high analog input impedance eliminates the need for a driver amplifier in front of the AD7608, allowing for direct connection to the source or sensor. With the need for a driver amplifier eliminated, bipolar supplies (which are often a source of noise in a system) can be removed from the signal chain.

#### Analog Input Clamp Protection

Figure 31 shows the analog input structure of the AD7608. Each AD7608 analog input contains clamp protection circuitry. Despite single 5 V supply operation, this analog input clamp protection allows for an input overvoltage up to  $\pm 16.5$  V.

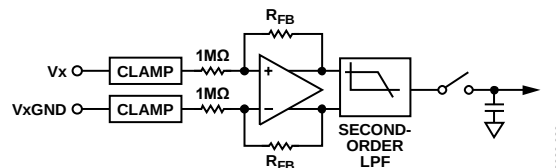


Figure 31. Analog Input Circuitry

Figure 32 shows the voltage vs. current characteristic of the clamp circuit. For input voltages of up to  $\pm 16.5$  V, no current flows in the clamp circuit. For input voltages that are above  $\pm 16.5$  V, the AD7608 clamp circuitry turns on.

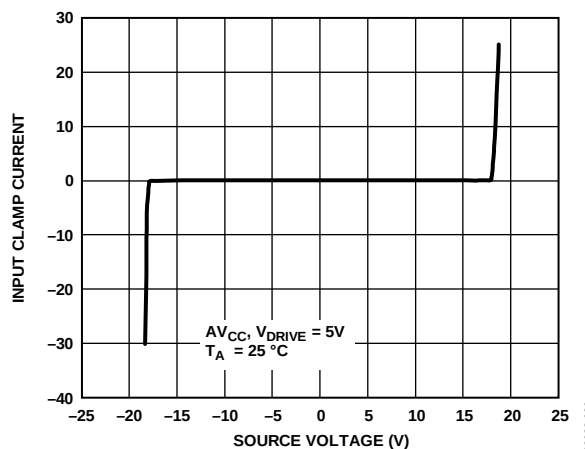


Figure 32. Input Protection Clamp Profile

A series resistor should be placed on the analog input channels to limit the current to  $\pm 10$  mA for input voltages above  $\pm 16.5$  V. In an application where there is a series resistance on an analog input channel, Vx, a corresponding resistance is required on the analog input GND channel, VxGND (see Figure 33). If there is no corresponding resistor on the VxGND channel, an offset error occurs on that channel.

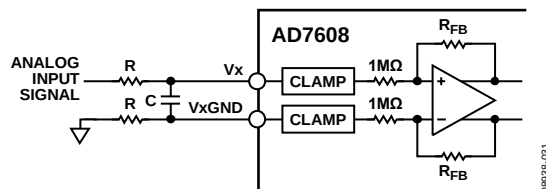


Figure 33. Input Resistance Matching on the Analog Input

### Analog Input Antialiasing Filter

An analog antialiasing filter (a second-order Butterworth) is also provided on the AD7608. Figure 34 and Figure 35 show the frequency and phase response, respectively, of the analog antialiasing filter. In the  $\pm 5$  V range, the  $-3$  dB frequency is typically 15 kHz. In the  $\pm 10$  V range, the  $-3$  dB frequency is typically 23 kHz.

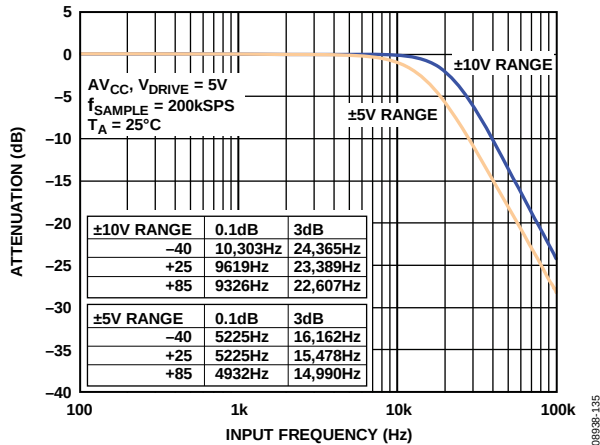


Figure 34. Analog Antialiasing Filter Frequency Response

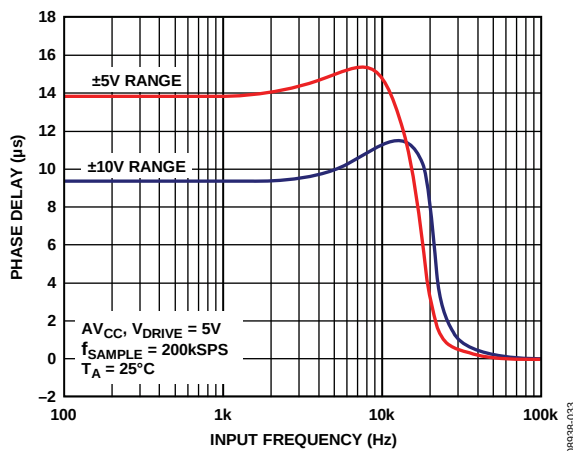


Figure 35. Analog Antialiasing Filter Phase Response

### Track-and-Hold Amplifiers

The track-and-hold amplifiers on the AD7608 allow the ADC to accurately acquire an input sine wave of full-scale amplitude to 18-bit resolution. The track-and-hold amplifiers sample their respective inputs simultaneously on the rising edge of CONVST x. The aperture time for track-and-hold (that is, the delay time between the external CONVST x signal and the

track-and-hold actually going into hold) is well matched, by design, across all eight track-and-holds on one device and from device to device. This matching allows more than one AD7608 device to be sampled simultaneously in a system.

The end of the conversion process across all eight channels is indicated by the falling edge of BUSY; and it is at this point that the track-and-holds return to track mode, and the acquisition time for the next set of conversions begins.

The conversion clock for the part is internally generated, and the conversion time for all channels is 4  $\mu$ s on the AD7608. The BUSY signal returns low after all eight conversions to indicate the end of the conversion process. On the falling edge of BUSY, the track-and-hold amplifiers return to track mode. New data can be read from the output register via the parallel or serial interface after BUSY goes low; or, alternatively, data from the previous conversion can be read while BUSY is high. Reading data from the AD7608 while a conversion is in progress has little effect on performance and allows a faster throughput to be achieved. In parallel mode at  $V_{DRIVE} > 3.3$  V, the SNR is reduced by  $\sim 1.5$  dB when reading during a conversion.

### ADC TRANSFER FUNCTION

The output coding of the AD7608 is twos complement. The designed code transitions occur midway between successive integer LSB values, that is,  $1/2$  LSB,  $3/2$  LSB. The LSB size is FSR/262,144 for the AD7608. The ideal transfer characteristic for the AD7608 is shown in Figure 36.

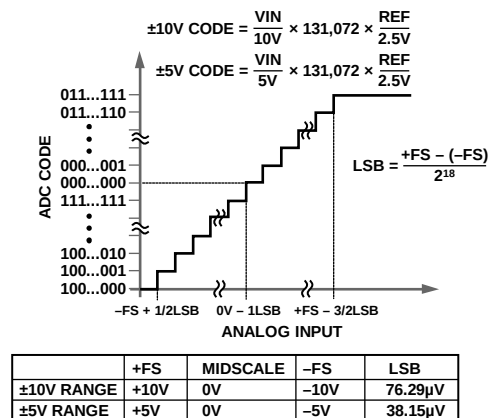


Figure 36. AD7608 Transfer Characteristic

The LSB size is dependent on the analog input range selected.

## INTERNAL/EXTERNAL REFERENCE

The AD7608 contains an on-chip 2.5 V band gap reference. The REFIN/REFOUT pin allows access to the 2.5 V reference that generates the on-chip 4.5 V reference internally, or it allows an external reference of 2.5 V to be applied to the AD7608. An externally applied reference of 2.5 V is also gained up to 4.5 V, using the internal buffer. This 4.5 V buffered reference is the reference used by the SAR ADC.

The REF SELECT pin is a logic input pin that allows the user to select between the internal reference or an external reference. If this pin is set to logic high, the internal reference is selected and enabled. If this pin is set to logic low, the internal reference is disabled and an external reference voltage must be applied to the REFIN/REFOUT pin. The internal reference buffer is always enabled. After a reset, the AD7608 operates in the reference mode selected by the REF SELECT pin. Decoupling is required on the REFIN/REFOUT pin for both the internal and external reference options. A 10  $\mu\text{F}$  ceramic capacitor is required on the REFIN/REFOUT pin.

The AD7608 contains a reference buffer configured to gain the REF voltage up to  $\sim 4.5$  V, as shown in Figure 37. The REFCAPA and REFCAPB pins must be shorted together externally, and a ceramic capacitor of 10  $\mu\text{F}$  applied to REFGND, to ensure that the reference buffer is in closed-loop operation. The reference voltage available at the REFIN/REFOUT pin is 2.5 V.

When the AD7608 is configured in external reference mode, the REFIN/REFOUT pin is a high input impedance pin. For applications using multiple AD7608 devices, the following configurations are recommended, depending on the application requirements.

### External Reference Mode

One [ADR421](#) external reference can be used to drive the REFIN/REFOUT pins of all AD7608 devices (see Figure 38). In this configuration, each REFIN/REFOUT pin of the AD7608 should be decoupled with at least a 100 nF decoupling capacitor.

### Internal Reference Mode

One AD7608 device, configured to operate in the internal reference mode, can be used to drive the remaining AD7608 devices, which are configured to operate in external reference mode (see Figure 39). The REFIN/REFOUT pin of the AD7608, configured in internal reference mode, should be decoupled using a 10  $\mu\text{F}$  ceramic decoupling capacitor. The other AD7608 devices, configured in external reference mode, should use at least a 100 nF decoupling capacitor on their REFIN/REFOUT pins.

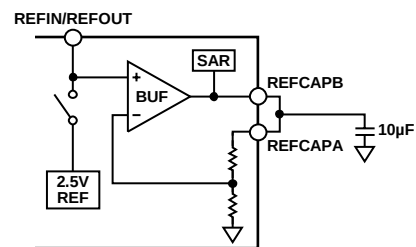


Figure 37. Reference Circuitry

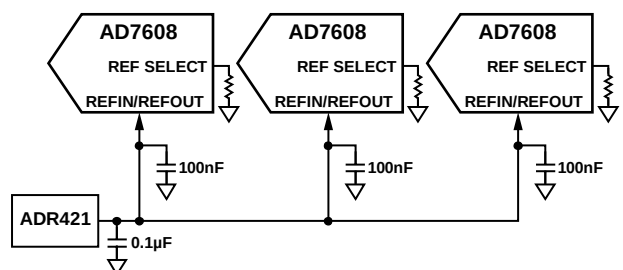


Figure 38. Single External Reference Driving Multiple AD7608 REFIN Pins

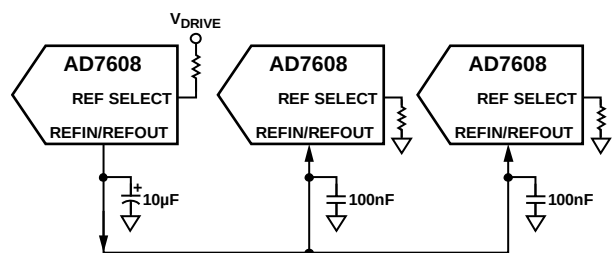


Figure 39. Internal Reference Driving Multiple AD7608 REFIN Pins

## TYPICAL CONNECTION DIAGRAM

Figure 40 shows the typical connection diagram for the AD7608. There are four AVCC supply pins on the part, and each of the four pins should be decoupled using a 100 nF capacitor at each supply pin and a 10  $\mu$ F capacitor at the supply source. The AD7608 can operate with the internal reference or an externally applied reference. In this configuration, the AD7608 is configured to operate with the internal reference. When using a single AD7608 device on the board, the REFIN/REFOUT pin should be decoupled with a 10  $\mu$ F capacitor. Refer to the Internal/External Reference section when using an application with multiple AD7608 devices. The REFCAPA and REFCAPB pins are shorted together and decoupled with a 10  $\mu$ F ceramic capacitor.

The V<sub>DRIVE</sub> supply is connected to the same supply as the processor. The V<sub>DRIVE</sub> voltage controls the voltage value of the output logic signals. For layout, decoupling, and grounding hints, see the Layout Guidelines section.

After supplies have been applied to the AD7608, apply a RESET signal to the device to ensure it is configured for the correct mode of operation.

## POWER-DOWN MODES

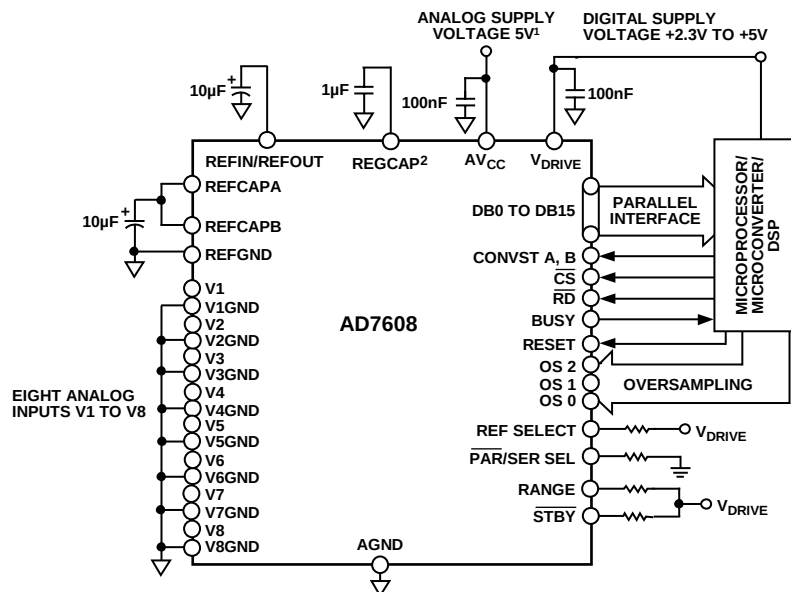
There are two power-down modes available on the AD7608: standby mode and shutdown mode. The STBY pin controls whether the AD7608 is in normal mode or in one of the two power-down modes.

The power-down mode is selected through the state of the RANGE pin when the STBY pin is low. Table 7 shows the configurations required to choose the desired power-down mode. When the AD7608 is placed in standby mode, the current consumption is 8 mA maximum and power-up time is approximately 100  $\mu$ s because the capacitor on the REFCAPA and REFCAPB pins must charge up. In standby mode, the on-chip reference and regulators remain powered up, and the amplifiers and ADC core are powered down.

When the AD7608 is placed in shutdown mode, the current consumption is 11  $\mu$ A maximum and power-up time is approximately 13 ms (external reference mode). In shutdown mode, all circuitry is powered down. When the AD7608 is powered up from shutdown mode, a RESET signal must be applied to the AD7608 after the required power-up time has elapsed.

Table 7. Power-Down Mode Selection

| Power-Down Mode | STBY | RANGE |
|-----------------|------|-------|
| Standby         | 0    | 1     |
| Shutdown        | 0    | 0     |



<sup>1</sup>DECOUPLING SHOWN ON THE AV<sub>CC</sub> PIN APPLIES TO EACH AV<sub>CC</sub> PIN (PIN 1, PIN 37, PIN 38, PIN 48). DECOUPLING CAPACITOR CAN BE SHARED BETWEEN AV<sub>CC</sub> PIN 37 AND PIN 38.

<sup>2</sup>DECOUPLING SHOWN ON THE REGCAP PIN APPLIES TO EACH REGCAP PIN (PIN 36, PIN 39).

Figure 40. Typical Connection Diagram

## CONVERSION CONTROL

### Simultaneous Sampling on All Analog Input Channels

The AD7608 allows simultaneous sampling of all analog input channels. All channels are sampled simultaneously when both CONVST x pins (CONVST A, CONVST B) are tied together. A single CONVST x signal is used to control both CONVST x inputs. The rising edge of this common CONVST x signal initiates simultaneous sampling on all analog input channels.

The AD7608 contains an on-chip oscillator that is used to perform the conversions. The conversion time for all ADC channels is  $t_{\text{CONV}}$ . The BUSY signal indicates to the user when conversions are in progress, so when the rising edge of CONVST x is applied, BUSY goes logic high and transitions low at the end of the entire conversion process. The falling edge of the BUSY signal is used to place all eight track-and-hold amplifiers back into track mode. The falling edge of BUSY also indicates that the new data can now be read from the parallel bus (DB[15:0]), or the D<sub>OUT</sub>A and D<sub>OUT</sub>B serial data lines.

### Simultaneously Sampling Two Sets of Channels

The AD7608 also allows the analog input channels to be sampled simultaneously in two sets. This can be used in power-line protection and measurement systems to compensate for phase differences introduced by PT and CT transformers. In a 50 Hz system, this allows for up to 9° of phase compensation; and in a 60 Hz system, it allows for up to 10° of phase compensation.

This is accomplished by pulsing the two CONVST x pins independently and is possible only if oversampling is not in use. CONVST A is used to initiate simultaneous sampling of the first set of channels (V1 to V4) and CONVST B is used to initiate simultaneous sampling on the second set of analog input channels (V5 to V8), as illustrated in Figure 41. On the rising edge of CONVST A, the track-and-hold amplifiers for the first set of channels are placed into hold mode. On the rising edge of CONVST B, the track-and-hold amplifiers for the second set of channels are placed into hold mode. The conversion process begins once both rising edges of CONVST x have occurred; therefore BUSY goes high on the rising edge of the later CONVST x signal. In Table 3, Time  $t_5$  indicates the maximum allowable time between CONVST x sampling points.

There is no change to the data read process when using two separate CONVST x signals.

Connect all unused analog input channels to AGND. The results for any unused channels are still included in the data read because all channels are always converted.

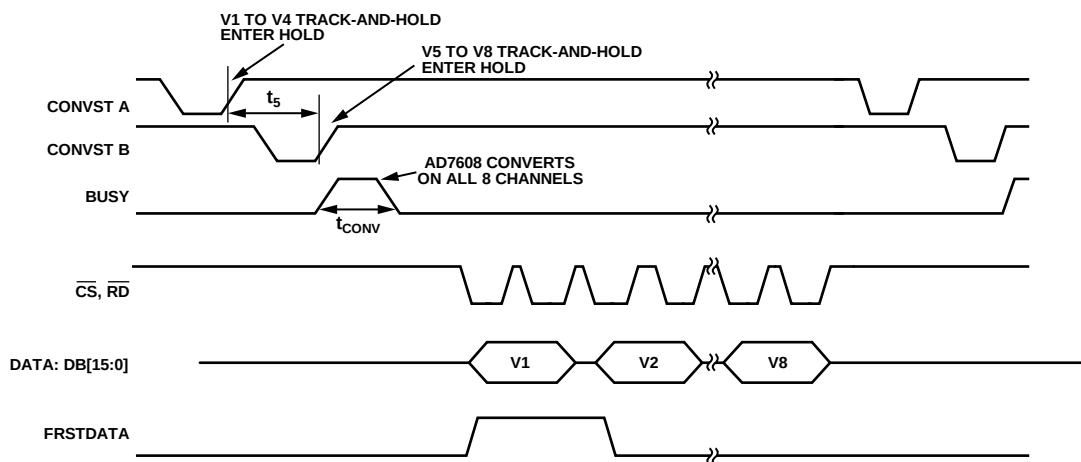


Figure 41. Simultaneous Sampling on Channel Sets Using Independent CONVST A/CONVST B Signals—Parallel Mode

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## DIGITAL INTERFACE

The AD7608 provides two interface options: a parallel interface and high speed serial interface. The required interface mode is selected via the PAR/SER SEL pin.

The operation of the interface modes is discussed in the following sections.

### PARALLEL INTERFACE (PAR/SER SEL = 0)

Data can be read from the AD7608 via the parallel data bus with standard  $\overline{CS}$  and  $\overline{RD}$  signals. To read the data over the parallel bus, the PAR/SER SEL pin should be tied low. The  $\overline{CS}$  and  $\overline{RD}$  input signals are internally gated to enable the conversion result onto the data bus. The data lines, DB15 to DB0, leave their high impedance state when both  $\overline{CS}$  and  $\overline{RD}$  are logic low.

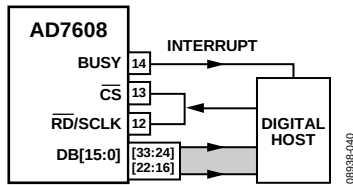


Figure 42. AD7608 interface diagram—One AD7608 Using the Parallel Bus;  $\overline{CS}$  and  $\overline{RD}$  Shorted Together

The rising edge of the  $\overline{CS}$  input signal three-states the bus and the falling edge of the  $\overline{CS}$  input signal takes the bus out of the high impedance state.  $\overline{CS}$  is the control signal that enables the data lines, it is the function that allows multiple AD7608 devices to share the same parallel data bus.

The  $\overline{CS}$  signal can be permanently tied low, and the  $\overline{RD}$  signal can be used to access the conversion results as shown in Figure 4. A read operation of new data can take place after the BUSY signal goes low (Figure 2), or alternatively a read operation of data from the previous conversion process can take place while BUSY is high (Figure 3).

The  $\overline{RD}$  pin is used to read data from the output conversion results register. Two  $\overline{RD}$  pulses are required to read the full 18-bit conversion result from each channel. Applying a sequence of 16  $\overline{RD}$  pulses to the AD7608  $\overline{RD}$  pin clocks the conversion results out from each channel onto the 16-bit parallel output bus in ascending order. The first  $\overline{RD}$  falling edge after BUSY goes low clocks out DB[17:2] of the V1 result, the next  $\overline{RD}$  falling edge updates the bus with DB[1:0] of V1 result. It takes 16  $\overline{RD}$  pulses to read the eight 18-bit conversion results from the AD7608. On the AD7608, the 16<sup>th</sup> falling edge of  $\overline{RD}$  clocks out the DB[1:0] conversion result for Channel V8. When the  $\overline{RD}$  signal is logic low, it enables the data conversion result from each channel to be transferred to the digital host (DSP, FPGA).

When there is only one AD7608 in a system/board and it does not share the parallel bus, data can be read using just one control signal from the digital host. The  $\overline{CS}$  and  $\overline{RD}$  signals can be tied together as shown in Figure 5. In this case, the data bus comes out of three-state on the falling edge of  $\overline{CS}/\overline{RD}$ . The combined  $\overline{CS}$  and  $\overline{RD}$  signal allows the data to be clocked out of the AD7608 and to be read by the digital host. In this case,  $\overline{CS}$  is used to frame the data transfer of each data channel. In this case, 16  $\overline{CS}$  pulses are required to read the eight channels of data.

### SERIAL INTERFACE ( $\overline{\text{PAR/SER SEL}} = 1$ )

To read data back from the AD7608 over the serial interface, the  $\overline{\text{PAR/SER SEL}}$  pin should be tied high. The  $\overline{\text{CS}}$  and SCLK signals are used to transfer data from the AD7608. The AD7608 has two serial data output pins, D<sub>OUTA</sub>, and D<sub>OUTB</sub>. Data can be read back from the AD7608 using one or both of these D<sub>OUT</sub> lines. For the AD7608, conversion results from Channel V1 to Channel V4 first appear on D<sub>OUTA</sub> while conversion results from Channel V5 to Channel V8 first appear on D<sub>OUTB</sub>.

The  $\overline{\text{CS}}$  falling edge takes the data output lines (D<sub>OUTA</sub> and D<sub>OUTB</sub>) out of three-state and clocks out the MSB of the conversion result. The rising edge of SCLK clocks all subsequent data bits onto the serial data outputs, D<sub>OUTA</sub> and D<sub>OUTB</sub>. The  $\overline{\text{CS}}$  input can be held low for the entire serial read, or it can be pulsed to frame each channel read of 18 SCLK cycles.

Figure 43 shows a read of eight simultaneous conversion results using two D<sub>OUT</sub> lines on the AD7608. In this case, a 72 SCLK transfer is used to access data from the AD7608 and  $\overline{\text{CS}}$  is held low to frame the entire 72 SCLK cycles. Data can also be clocked out using just one D<sub>OUT</sub> line, in which case D<sub>OUTA</sub> is recommended to access all conversion data as the channel data is output in ascending order. For the AD7608 to access all eight conversion results on one D<sub>OUT</sub> line, a total of 144 SCLK cycles are required. These 144 SCLK cycles can be framed by one  $\overline{\text{CS}}$  signal or each group of 18 SCLK cycles can be individually framed by the  $\overline{\text{CS}}$  signal. The disadvantage of using just one D<sub>OUT</sub> line is that the throughput rate is reduced if reading after conversion. The unused D<sub>OUT</sub> line should be left unconnected in serial mode. For the AD7608, if D<sub>OUTB</sub> is used as a single D<sub>OUT</sub> line, the channel results will output in the following order: V5, V6, V7, V8, V1, V2, V3, V4; however, the FRSTD<sub>DATA</sub> indicator returns low once V5 is read on D<sub>OUTB</sub>.

Figure 6 shows the timing diagram for reading one channel of data, framed by the  $\overline{\text{CS}}$  signal, from the AD7608 in serial mode.

The SCLK input signal provides the clock source for the serial read operation.  $\overline{\text{CS}}$  goes low to access the data from the AD7608. The falling edge of  $\overline{\text{CS}}$  takes the bus out of three-state and clocks out the MSB of the 18-bit conversion result. This MSB is valid on the first falling edge of the SCLK after the  $\overline{\text{CS}}$  falling edge. The subsequent 17 data bits are clocked out of the AD7608 on the SCLK rising edge. Data is valid on the SCLK falling edge. Eighteen clock cycles must be provided to the AD7608 to access each conversion result.

The FRSTD<sub>DATA</sub> output signal indicates when the first channel, V1, is being read back. When the  $\overline{\text{CS}}$  input is high, the FRSTD<sub>DATA</sub> output pin is in three-state. In serial mode, the falling edge of  $\overline{\text{CS}}$  takes FRSTD<sub>DATA</sub> out of three-state and sets the FRSTD<sub>DATA</sub> pin high indicating that the result from V1 is available on the D<sub>OUTA</sub> output data line. The FRSTD<sub>DATA</sub> output returns to a logic low following the 18<sup>th</sup> SCLK falling edge. If all channels are read on D<sub>OUTB</sub>, the FRSTD<sub>DATA</sub> output does not go high when V1 is output on the serial data output pin. It only goes high when V1 is available on D<sub>OUTA</sub> (and this is when V5 is available on D<sub>OUTB</sub>).

### READING DURING CONVERSION

Data can be read from the AD7608 while BUSY is high and conversions are in progress. This has little effect on the performance of the converter and allows a faster throughput rate to be achieved. A parallel or serial read may be performed during conversions and when oversampling may or may not be in use. Figure 3 shows the timing diagram for reading while BUSY is high in parallel or serial mode. Reading during conversions allows the full throughput rate to be achieved when using the serial interface with a V<sub>DRIVE</sub> of 3.3 V to 5.25 V.

Data can be read from the AD7608 at any time other than on the falling edge of BUSY because this is when the output data registers get updated with the new conversion data. Time t<sub>6</sub>, as outlined in Table 3, should be observed in this condition.

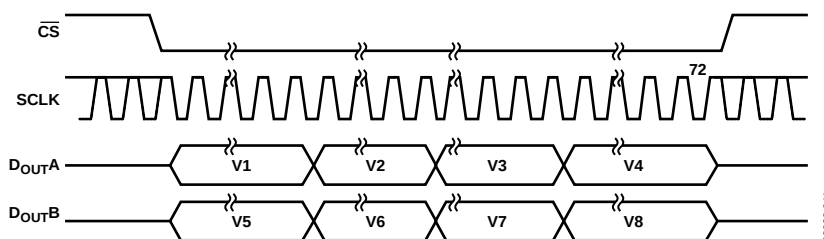


Figure 43. AD7608 Serial Interface with two D<sub>OUT</sub> Lines

## DIGITAL FILTER

The AD7608 contains an optional digital first-order sinc filter that should be used in applications where slower throughput rates are used or where higher signal-to-noise ratio or dynamic range is desirable. The oversampling ratio of the digital filter is controlled using the oversampling pins, OS [2:0] (see Table 8). OS 2 is the MSB control bit, and OS 0 is the LSB control bit. Table 8 provides the oversampling bit decoding to select the different oversample rates. The OS pins are latched on the falling edge of BUSY. This sets the oversampling rate for the next conversion (see Figure 45). In addition to the oversampling function, the output result is decimated to 18-bit resolution.

If the OS pins are set to select an OS ratio of 8, the next CONVST x rising edge takes the first sample for each channel, and the remaining seven samples for all channels are taken with an internally generated sampling signal. These samples are then averaged to yield an improvement in SNR performance. Table 8 shows typical SNR performance for both the  $\pm 10$  V and the  $\pm 5$  V range. As Table 8 indicates, there is an improvement in SNR as the OS ratio increases. As the OS ratio increases, the 3 dB frequency is reduced, and the allowed sampling frequency is also reduced. In an application where the required sampling frequency is 10 kSPS, an OS ratio of up to 16 can be used. In this case, the application sees an improvement in SNR, but the input 3 dB bandwidth is limited to  $\sim 6$  kHz.

The CONVST A and CONVST B pins must be tied/driven together when oversampling is turned on. When the oversampling function is turned on, the BUSY high time for the conversion process extends. The actual BUSY high time depends on the oversampling rate selected: the higher the oversampling rate, the longer the BUSY high, or total conversion time (see Table 3).

Figure 44 shows that the conversion time extends as the oversampling rate is increased, and the BUSY signal lengthens for the different oversampling rates. For example, a sampling frequency of 10 kSPS yields a cycle time of 100  $\mu$ s. Figure 44 shows OS  $\times 2$  and OS  $\times 4$ ; for a 10 kSPS example, there is adequate cycle time to further increase the oversampling rate and yield greater improvements in SNR performance. In an application where the initial sampling or throughput rate is at 200 kSPS, for example, and oversampling is turned on, the throughput rate must be reduced to accommodate the longer conversion time and to allow for the read. To achieve the fastest throughput rate possible when oversampling is turned on, the read can be performed during the BUSY high time. The falling edge of BUSY is used to update the output data registers with the new conversion data; therefore, the reading of conversion data should not occur on this edge.

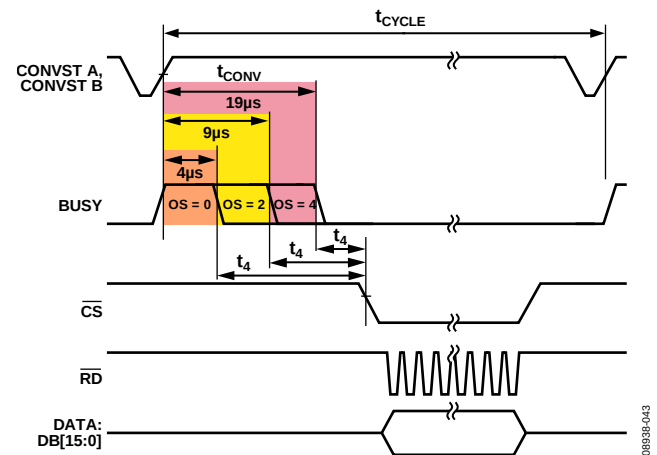


Figure 44. No Oversampling, Oversampling  $\times 2$ , and Oversampling  $\times 4$  While Using Read After Conversion

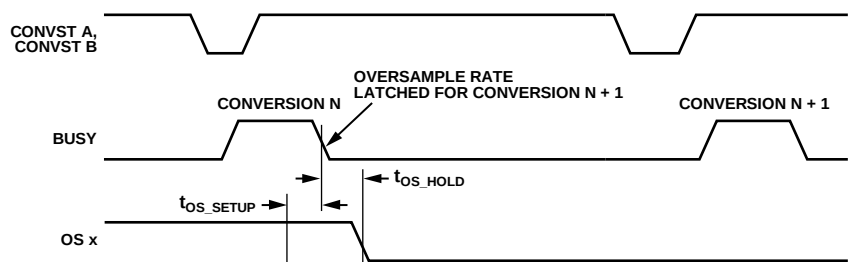


Figure 45. OS Pin Timing

Table 8. Oversample Bit Decoding

| OS [2:0] | OS Ratio | SNR $\pm 5$ V Range (dB) <sup>1</sup> | SNR $\pm 10$ V Range (dB) <sup>1</sup> | 3 dB BW $\pm 5$ V Range (kHz) | 3 dB BW $\pm 10$ V Range (kHz) | Maximum Throughput CONVST x Frequency (kHz) |
|----------|----------|---------------------------------------|----------------------------------------|-------------------------------|--------------------------------|---------------------------------------------|
| 000      | No OS    | 90.5                                  | 91.2                                   | 15                            | 22                             | 200                                         |
| 001      | 2        | 92.5                                  | 93.4                                   | 15                            | 22                             | 100                                         |
| 010      | 4        | 94.45                                 | 95.7                                   | 13.7                          | 18.5                           | 50                                          |
| 011      | 8        | 96.5                                  | 98                                     | 10.3                          | 11.9                           | 25                                          |
| 100      | 16       | 99.1                                  | 100.4                                  | 6                             | 6                              | 12.5                                        |
| 101      | 32       | 101.7                                 | 102.8                                  | 3                             | 3                              | 6.25                                        |
| 110      | 64       | 103                                   | 103.5                                  | 1.5                           | 1.5                            | 3.125                                       |
| 111      | Invalid  |                                       |                                        |                               |                                |                                             |

<sup>1</sup> SNR values taken with a full scale 100 Hz input signal.

Figure 46 to Figure 52 illustrates the effect of oversampling on the code spread in a dc histogram plot. As the oversample rate is increased, the spread of codes is reduced. (In Figure 46 to Figure 52,  $AV_{CC} = V_{DRIVE} = 5\text{ V}$  and the sampling rate was scaled with OS ratio.)

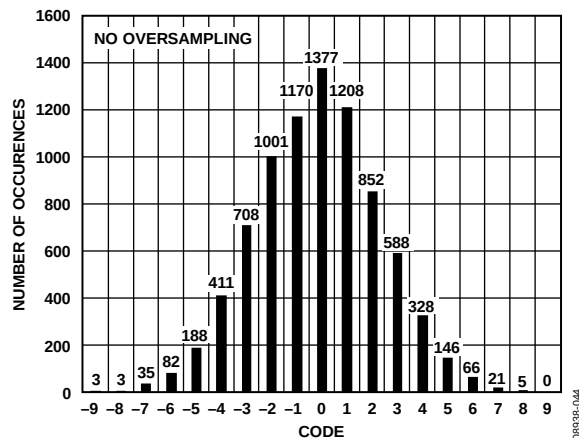


Figure 46. Histogram of Codes—No OS (18 Codes)

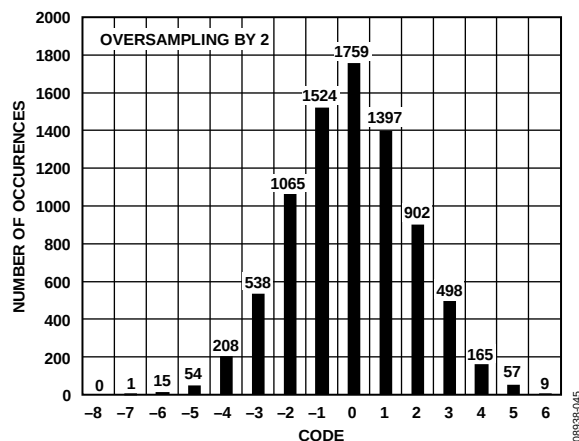


Figure 47. Histogram of Codes—OS  $\times$  2 (14 Codes)

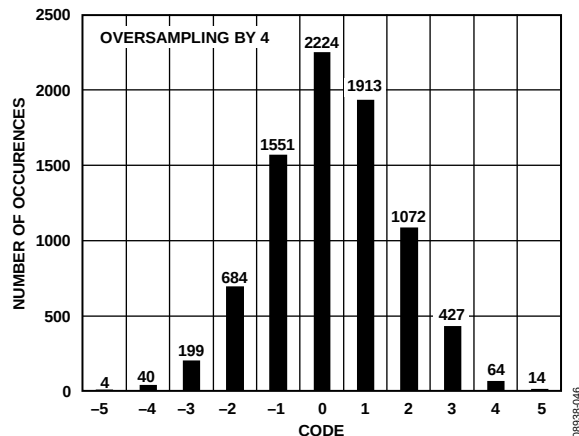


Figure 48. Histogram of Codes—OS  $\times$  4 (11 Codes)

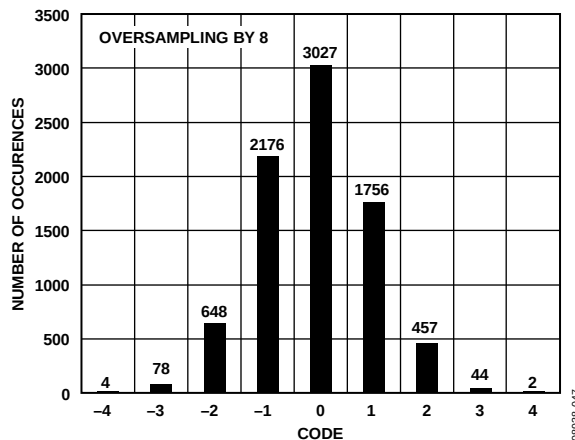


Figure 49. Histogram of Codes—OS  $\times$  8 (9 Codes)

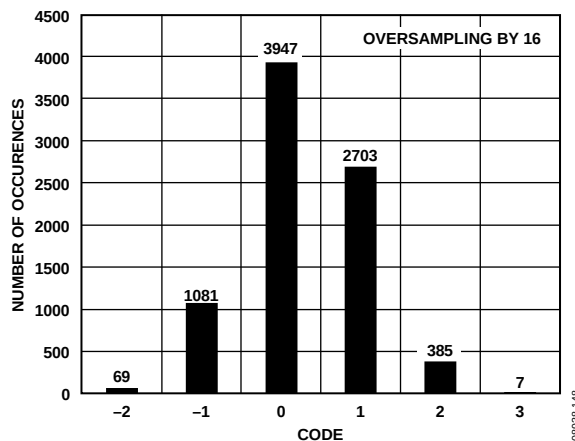


Figure 50. Histogram of Codes—OS  $\times$  16 (6 Codes)

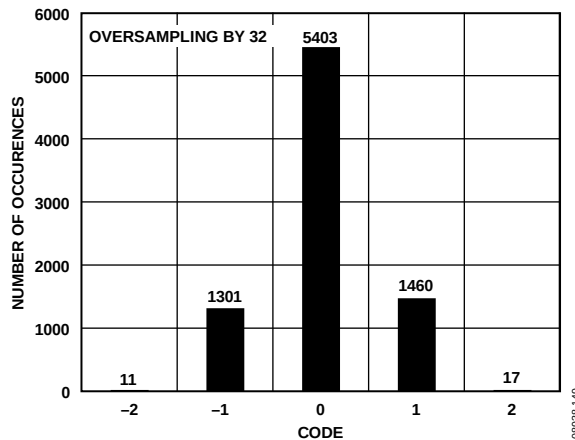


Figure 51. Histogram of Codes—OS  $\times$  32 (5 Codes)

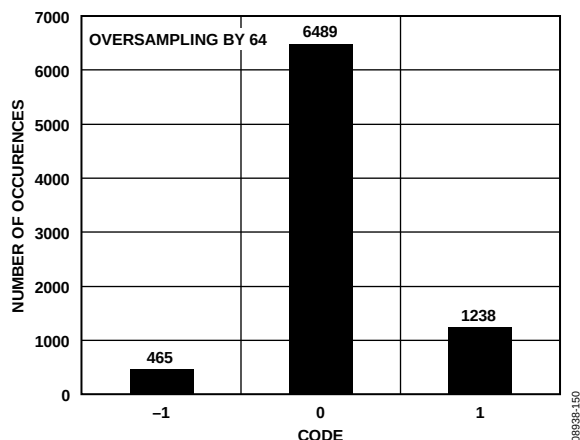


Figure 52. Histogram of Codes—OS × 64 (3 Codes)

When the oversampling mode is selected, this has the effect of adding a digital filter function after the ADC. The different oversampling rates and the CONVST × sampling frequency produces different digital filter frequency profiles.

Figure 53 to Figure 58 show the digital filter frequency profiles for oversampling by 2 to oversampling by 64. The combination of the analog antialiasing filter and the oversampling digital filter can be used to eliminate or reduce the complexity of the design of the filter before the AD7608. The digital filtering combines steep roll-off and linear phase response.

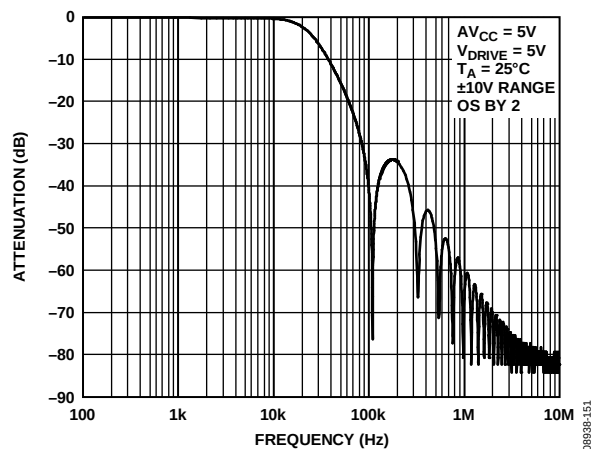


Figure 53. Digital Filter OS × 2

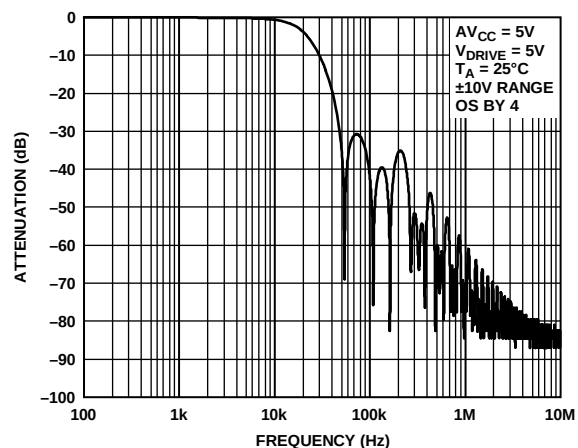


Figure 54. Digital Filter Response for OS × 4

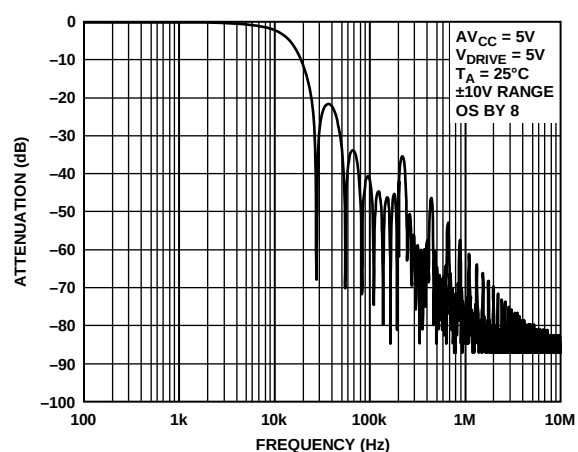


Figure 55. Digital Filter Response for OS × 8

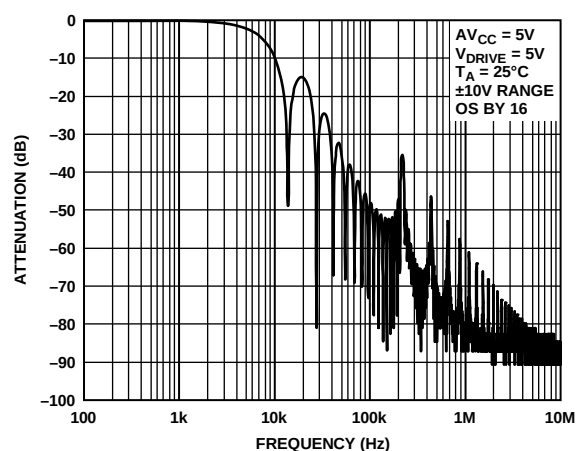
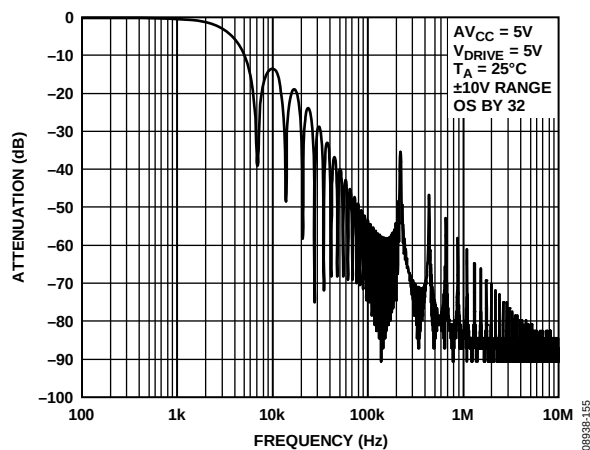
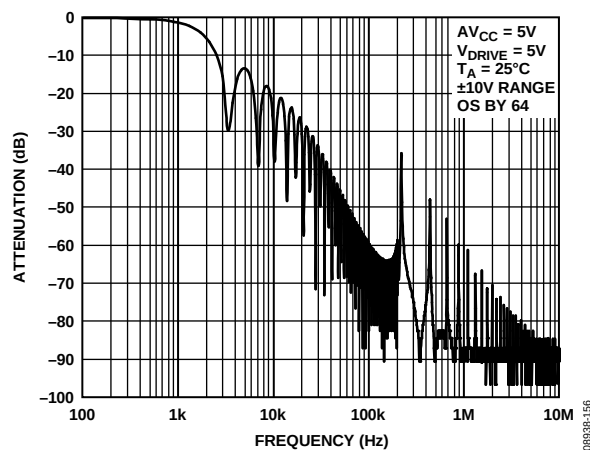


Figure 56. Digital Filter Response for OS × 16

Figure 57. Digital Filter Response for OS  $\times$  32Figure 58. Digital Filter Response for OS  $\times$  64

## LAYOUT GUIDELINES

The printed circuit board that houses the AD7608 should be designed so that the analog and digital sections are separated and confined to different areas of the board.

Use at least one ground plane. It can be common or split between the digital and analog sections. In the case of the split plane, the digital and analog ground planes should be joined in only one place, preferably as close as possible to the AD7608.

If the AD7608 is in a system where multiple devices require analog-to-digital ground connections, the connection should still be made at only one point: a star ground point should be established as close as possible to the AD7608. Good connections should be made to the ground plane. Avoid sharing one connection for multiple ground pins. Individual vias or multiple vias to the ground plane should be used for each ground pin.

Avoid running digital lines under the devices because doing so couples noise onto the die. Allow the analog ground plane to run under the AD7608 to avoid noise coupling. Fast switching signals like CONVST A, CONVST B, or clocks should be shielded with digital ground to avoid radiating noise to other sections of the board, and they should never run near analog signal paths. Avoid crossover of digital and analog signals. Run traces on layers in close proximity on the board at right angles to each other to reduce the effect of feedthrough through the board.

The power supply lines to the  $AV_{CC}$  and  $V_{DRIVE}$  pins on the AD7608 should use as large a trace as possible to provide low impedance paths and reduce the effect of glitches on the power supply lines. Where possible, use supply planes. Good connections should be made between the AD7608 supply pins and the power tracks on the board. Use a single via or multiple vias for each supply pin.

Good decoupling is also important to lower the supply impedance presented to the AD7608 and to reduce the magnitude of the supply spikes. The decoupling capacitors should be placed close to (ideally right up against) these pins and their corresponding ground pins. Place the decoupling capacitors for the REFIN/REFOUT pin and the REFCAPA and REFCAPB pins as close as possible to their respective AD7608 pins and where possible they should be placed on the same side of the board as the AD7608 device. Figure 59 shows the recommended decoupling on the top layer of the AD7608 board. Figure 60 shows bottom layer decoupling. Bottom layer decoupling is for the four  $AV_{CC}$  pins and the  $V_{DRIVE}$  pin.



Figure 59. Top Layer Decoupling REFIN/REFOUT, REFCAPA, REFCAPB, and REGCAP Pins

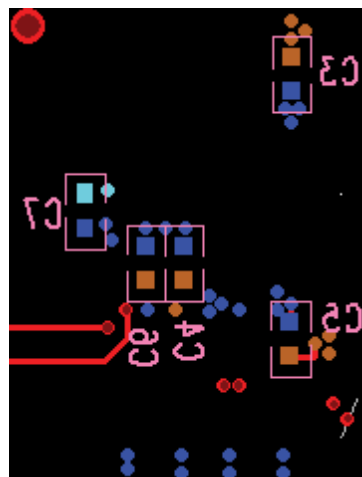


Figure 60. Bottom Layer Decoupling

To ensure good device-to-device performance matching, in a system that contains multiple AD7608 devices, a symmetrical layout between the AD7608 devices is important.

Figure 61 shows a layout with two devices. The  $AV_{CC}$  supply plane runs to the right of both devices. The  $V_{DRIVE}$  supply track runs to the left of the two devices. The reference chip is positioned between both the two devices and the reference voltage track runs north to Pin 42 of U1 and south to Pin 42 to U2. A solid ground plane is used.

These symmetrical layout principles can be applied to a system that contains more than two AD7608 devices. The AD7608 devices can be placed in a north-south direction with the reference voltage located midway between the AD7608 devices with the reference track running in the north-south direction similar to Figure 61.

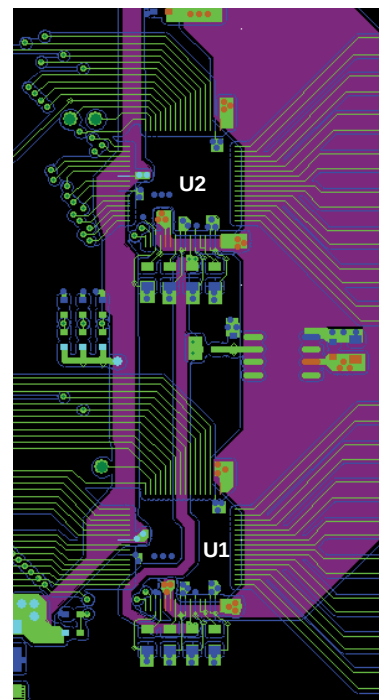
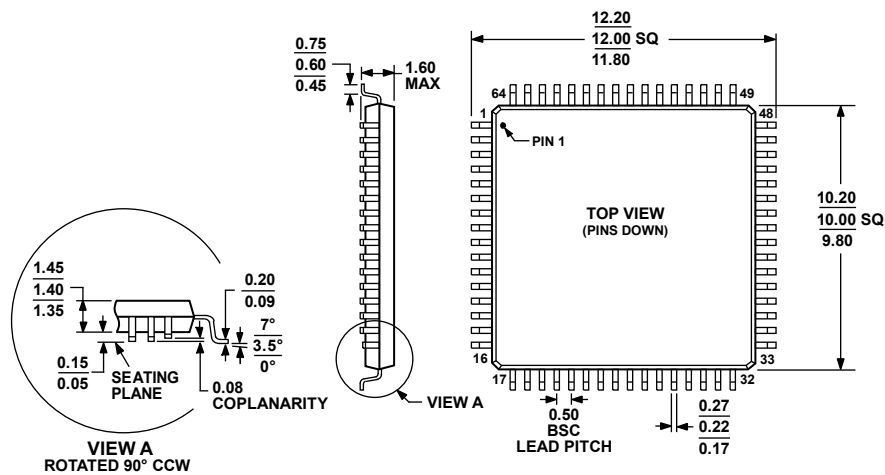


Figure 61. Layout for Multiple AD7608 Devices—Top Layer and Supply Plane Layer

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-026-BCD

Figure 62. 64-Lead Low Profile Quad Flat Package [LQFP]  
(ST-64-2)

Dimensions shown in millimeters

051706-A

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                          | Package Option |
|--------------------|-------------------|----------------------------------------------|----------------|
| AD7608BSTZ         | −40°C to +85°C    | 64-Lead Low Profile Quad Flat Package [LQFP] | ST-64-2        |
| AD7608BSTZ-RL      | −40°C to +85°C    | 64-Lead Low Profile Quad Flat Package [LQFP] | ST-64-2        |
| EVAL-AD7608SDZ     |                   | Evaluation Board for the AD7608              |                |
| EVAL-SDP-CB1Z      |                   | Converter Evaluation Development             |                |

<sup>1</sup> Z = RoHS Compliant Part.